

Tests of Silicon Strip Modules for the Upgrade of the ATLAS Detector at the LHC

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7th Feb 2012 Master Thesis Defense

@ DESY, Zeuthen Site



Outline



* ATLAS Detector at LHC & Upgrade: HL-LHC and PETAL2014

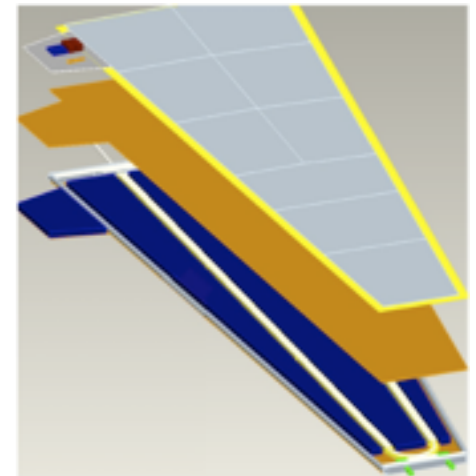
* Readout System Setup

* Readout Software & Test results

* Database

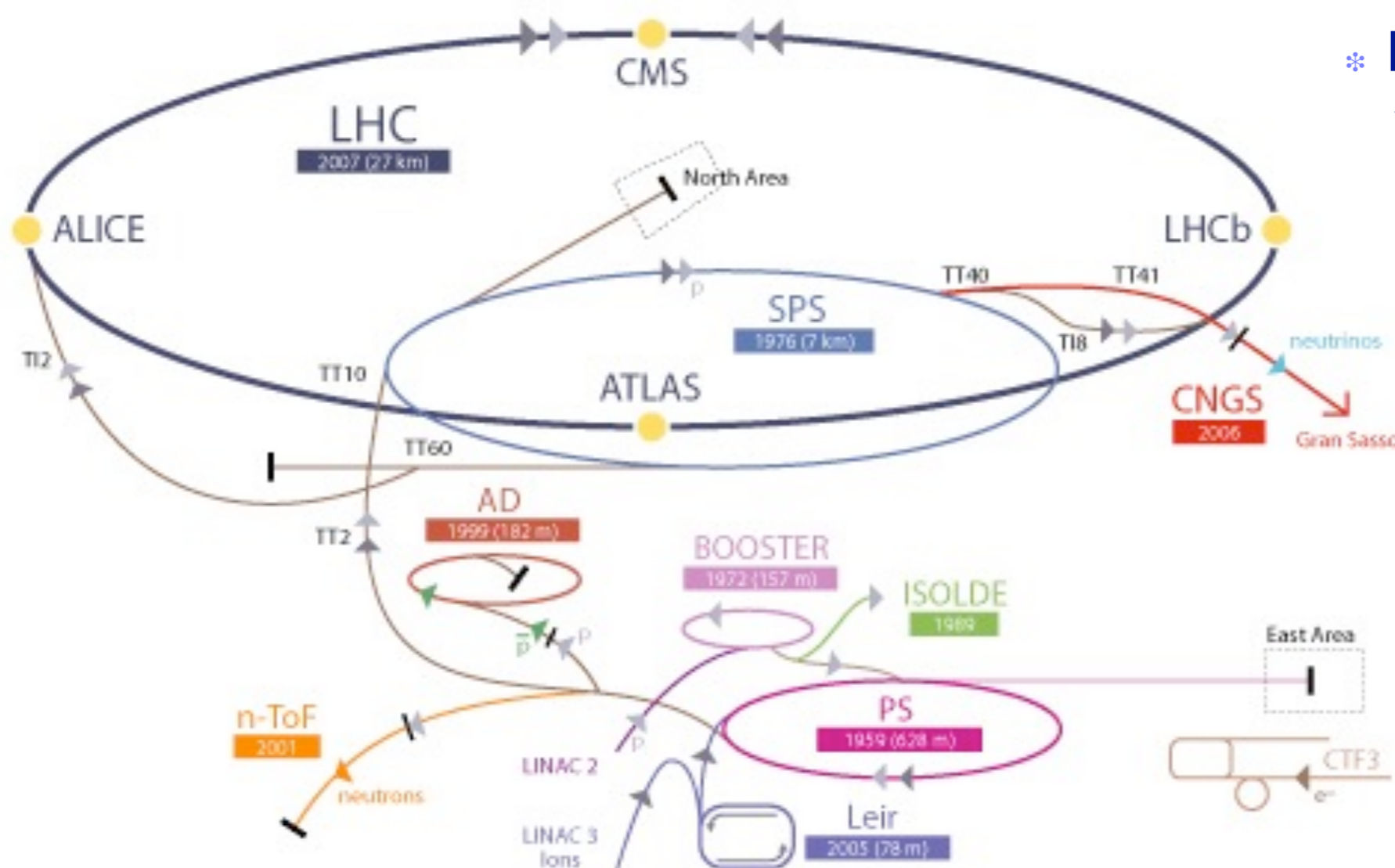
* Systematic Study of Readout System

* Summary & Conclusion & Outlook



The Large Hadron Collider (LHC)

CERN Accelerator Complex



* Proton- Proton Collider
with bunch crossing rate
25 ns

▶ p (proton) ▶ ion ▶ neutrons ▶ \bar{p} (antiproton) ▶ neutrinos ▶ electron
 ⇄⇄⇄ proton/antiproton conversion

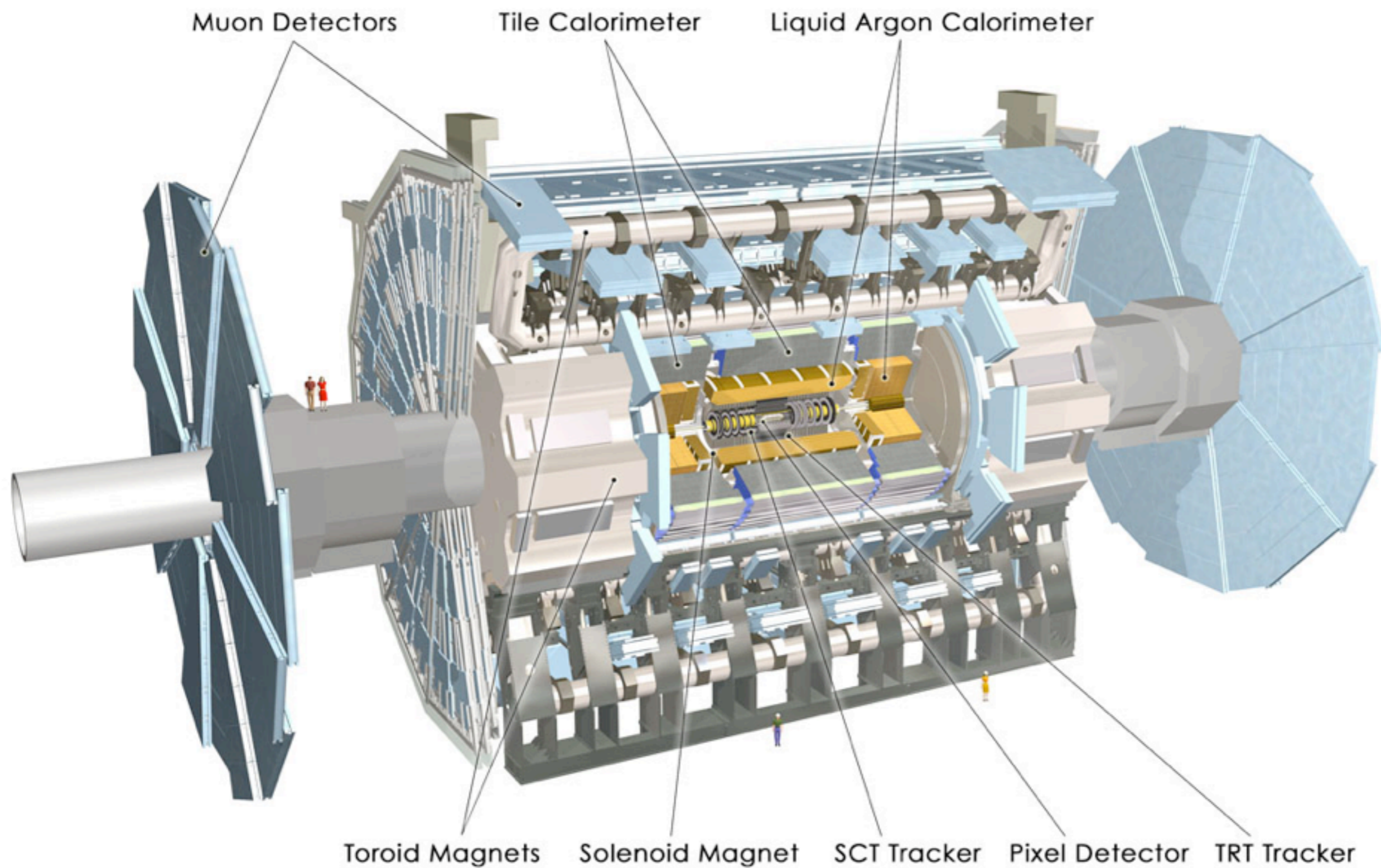
LHC Large Hadron Collider SPS Super Proton Synchrotron PS Proton Synchrotron

AD Antiproton Decelerator CTF3 Clic Test Facility

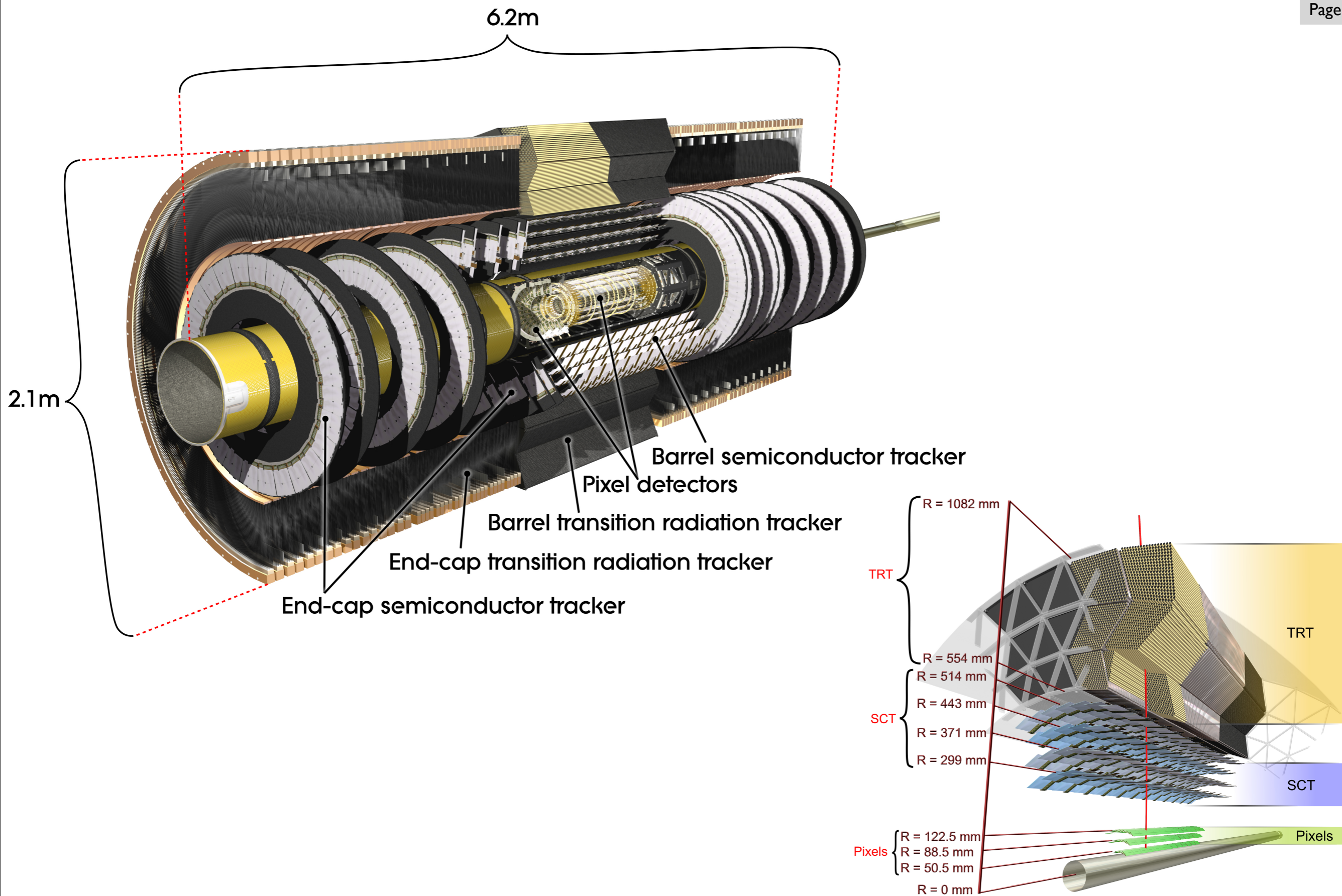
CNGS Cern Neutrinos to Gran Sasso ISOLDE Isotope Separator OnLine DEvice

LEIR Low Energy Ion Ring LINAC LINEar ACcelerator n-ToF Neutrons Time Of Flight

The Current ATLAS Detector



Inner Detector

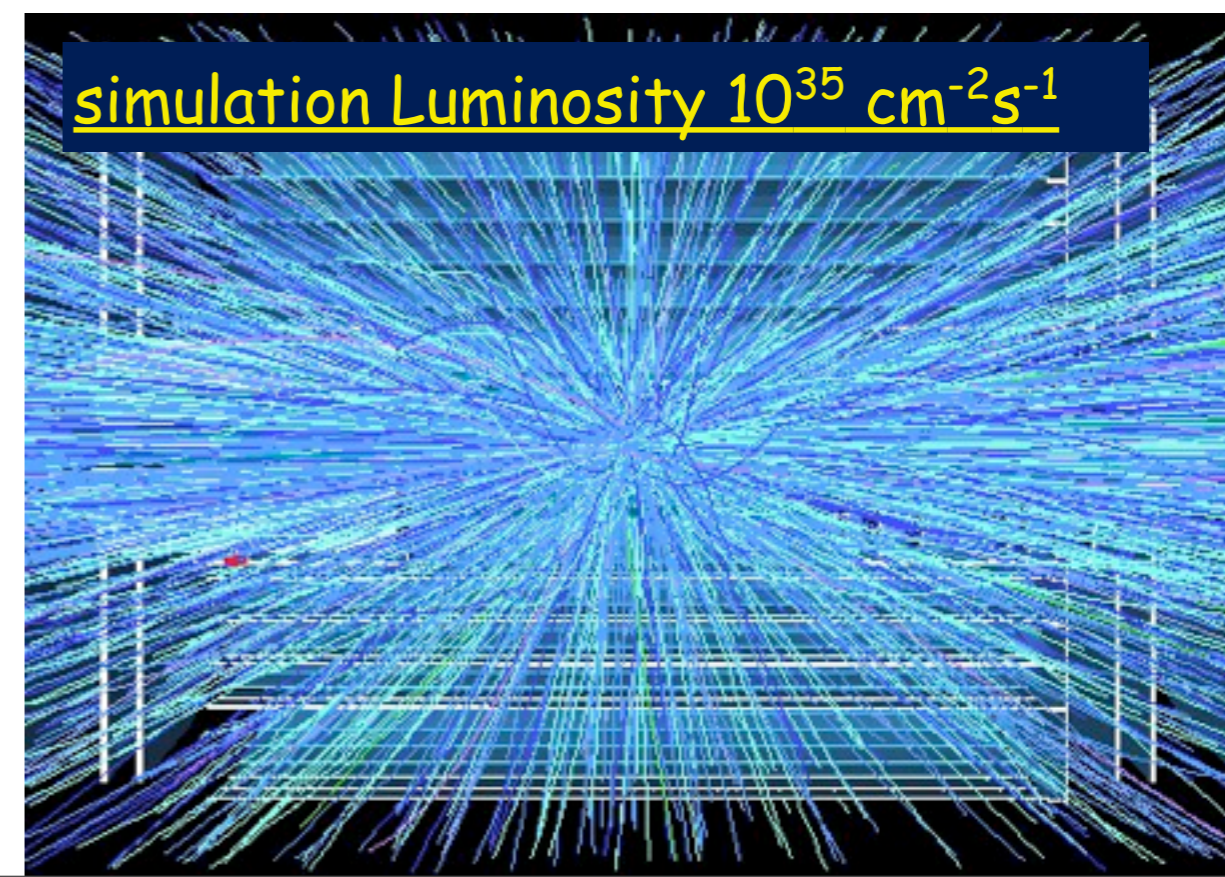
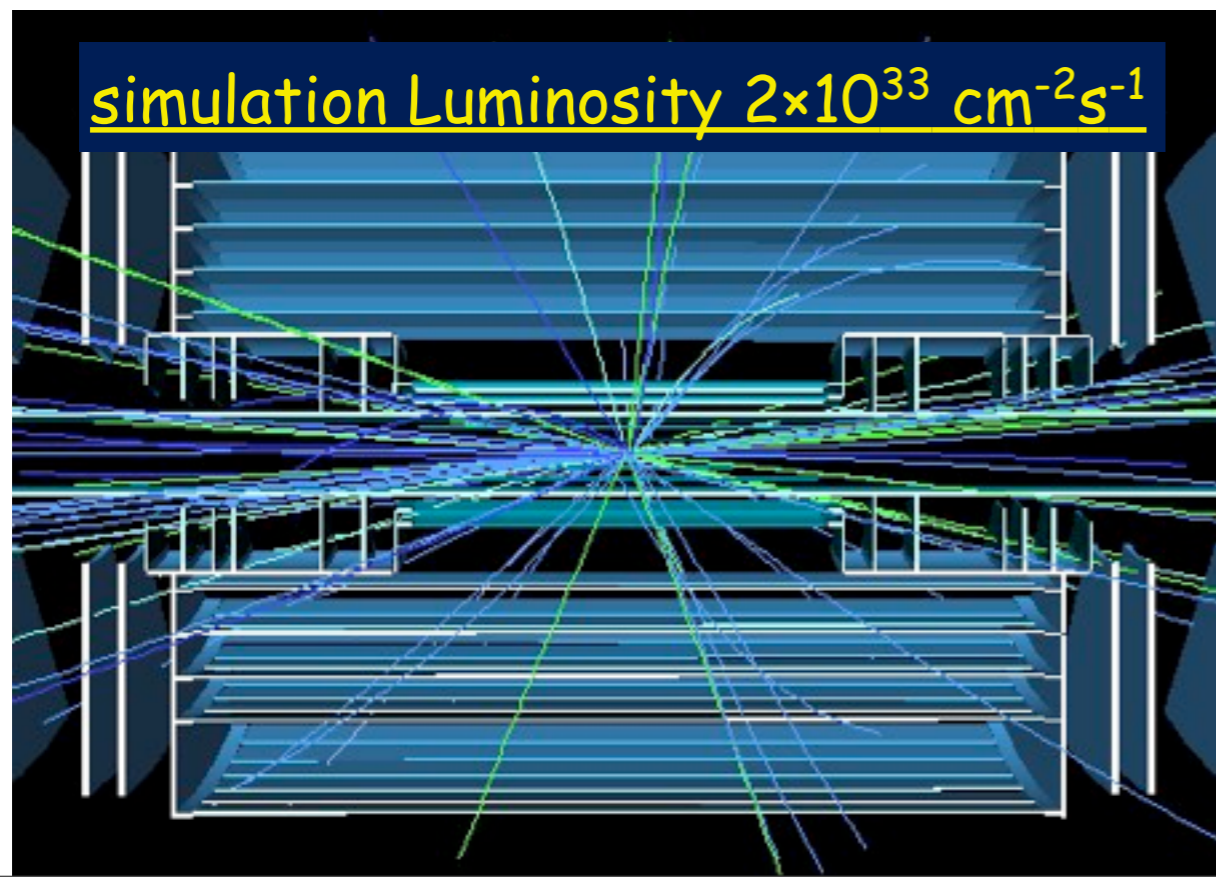


Upgrade of LHC

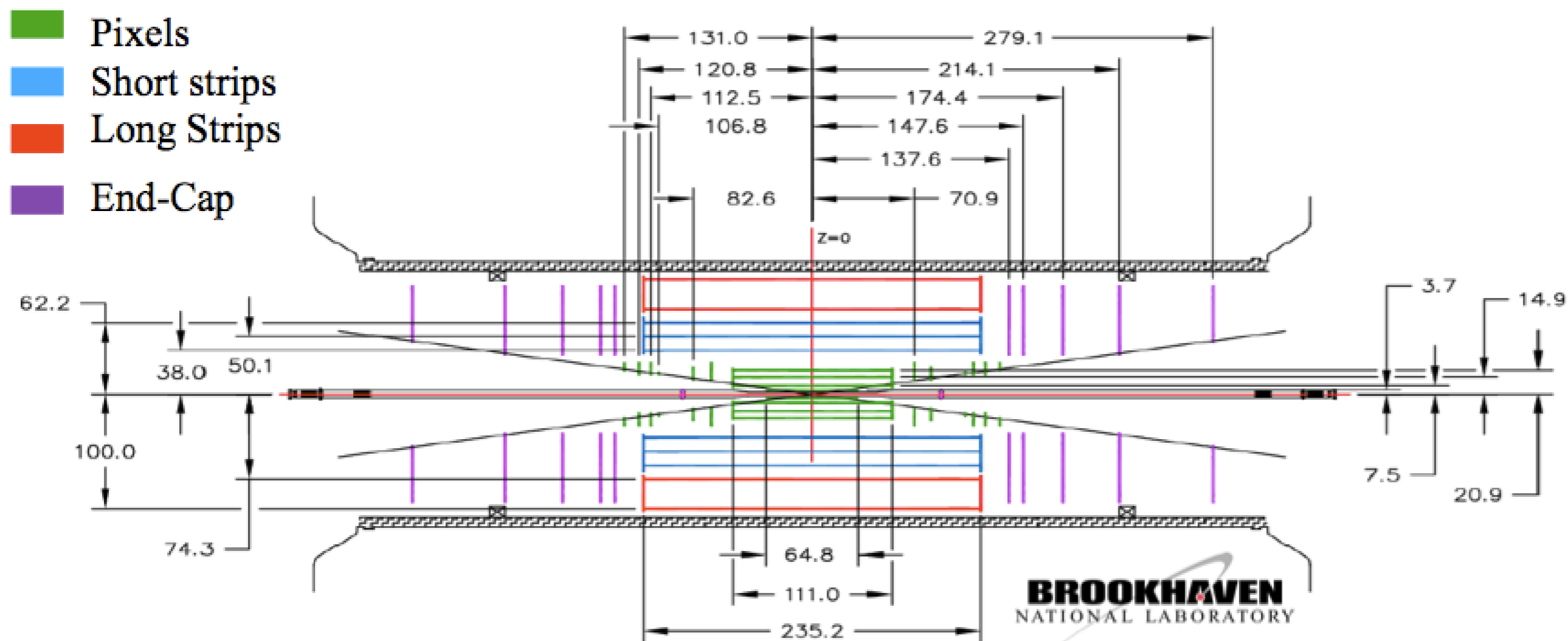
HL-LHC (High Luminosity Large Hadron Collider)

- * Upgrade of LHC & ATLAS Detector
 - to reduce the statistical uncertainties for measurements
- * the expected luminosity after upgrade in 2020: $5 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$
- * effects of higher luminosity for the detector: higher occupancy, higher radiation
- * upgrade:
 - higher granularity, increased electronic channels, radiation hardness, new powering schemes

Plots of tracks Simulation of ATLAS detector



Proposed Layout of the Inner Detector

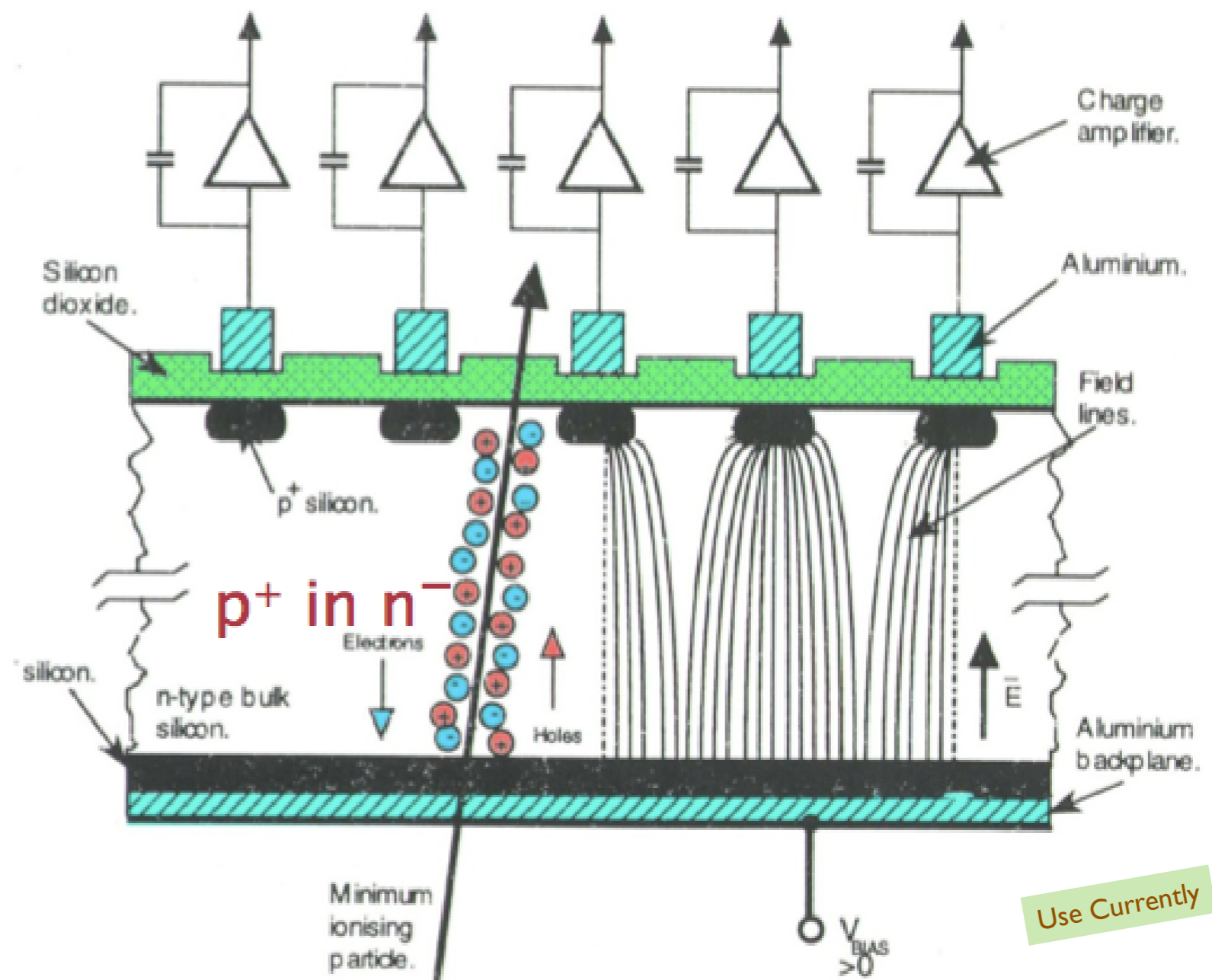


Silicon Strip Detector

- * Charge deposition in 300 μm thick silicon $\sim 22000 e$ (3.5 fC)
- * Electrons collected within ~ 10 ns, holes collected within ~ 25 ns, for 300 μm thick silicon

Currently use (SCT):
p in n sensor,
holes collected

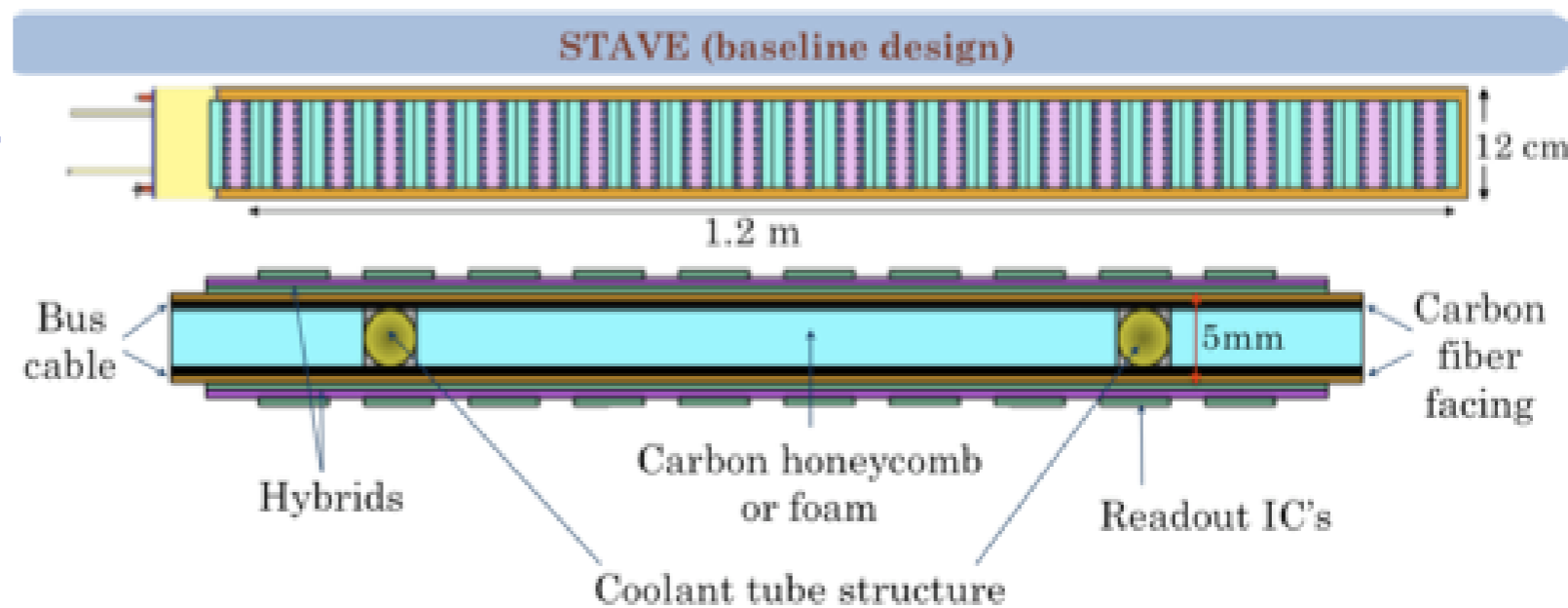
Upgrade (Silicon Strip Detector):
n in p sensor,
electrons collected



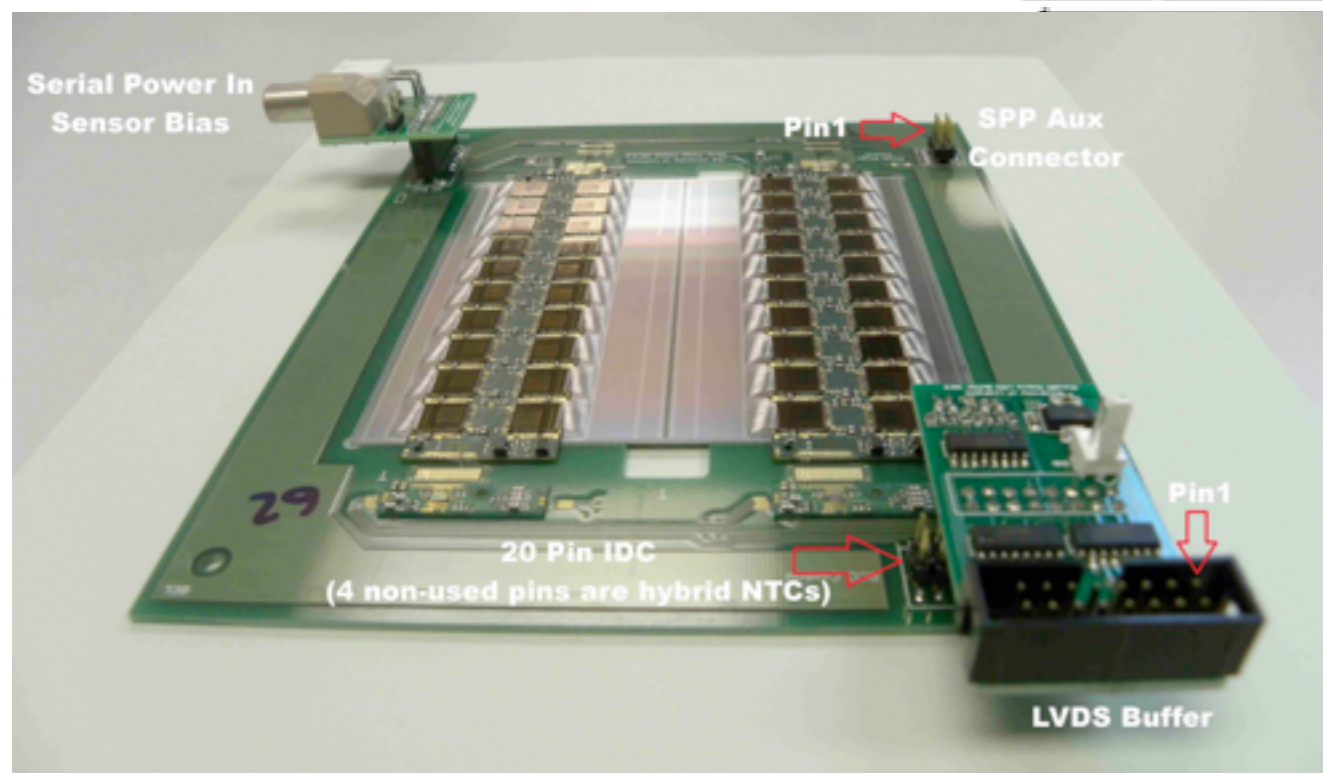
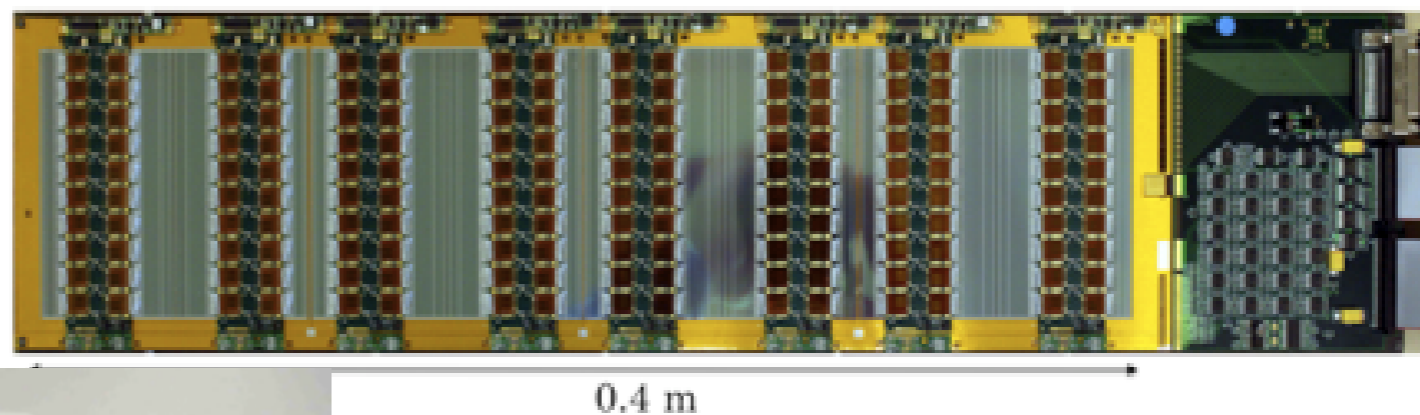
Use Currently

Upgrade of Silicon Strip Detector

Stave --->



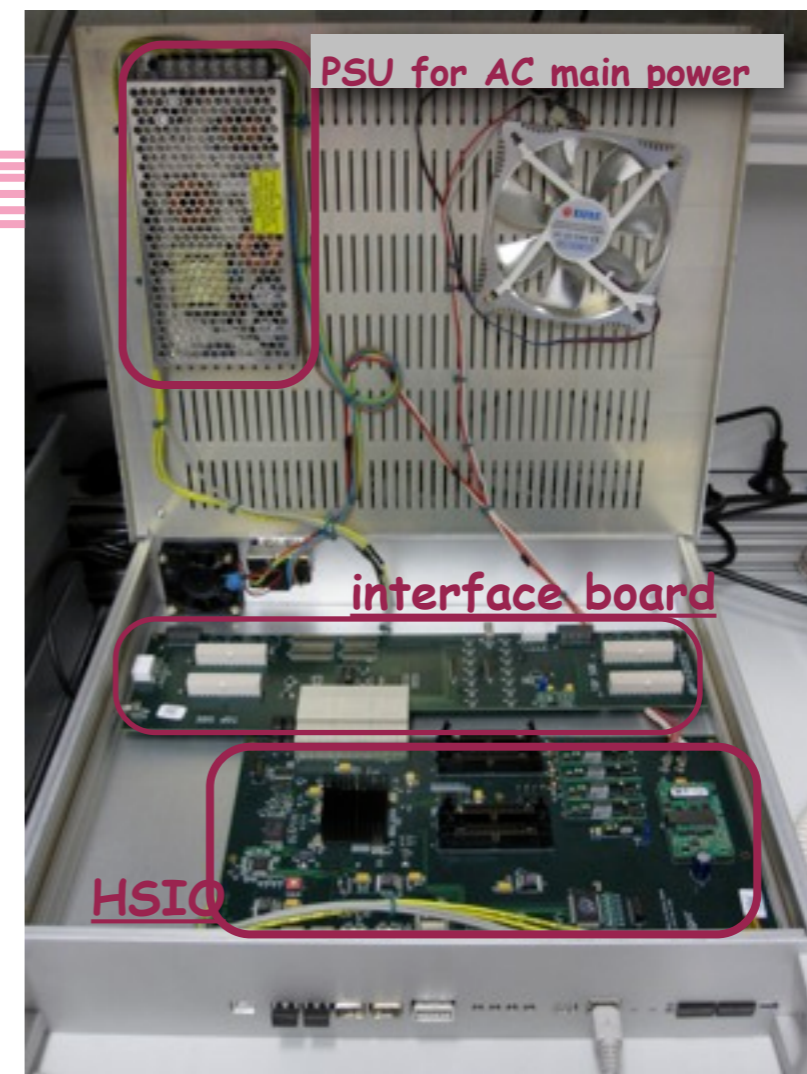
Stavelet --->



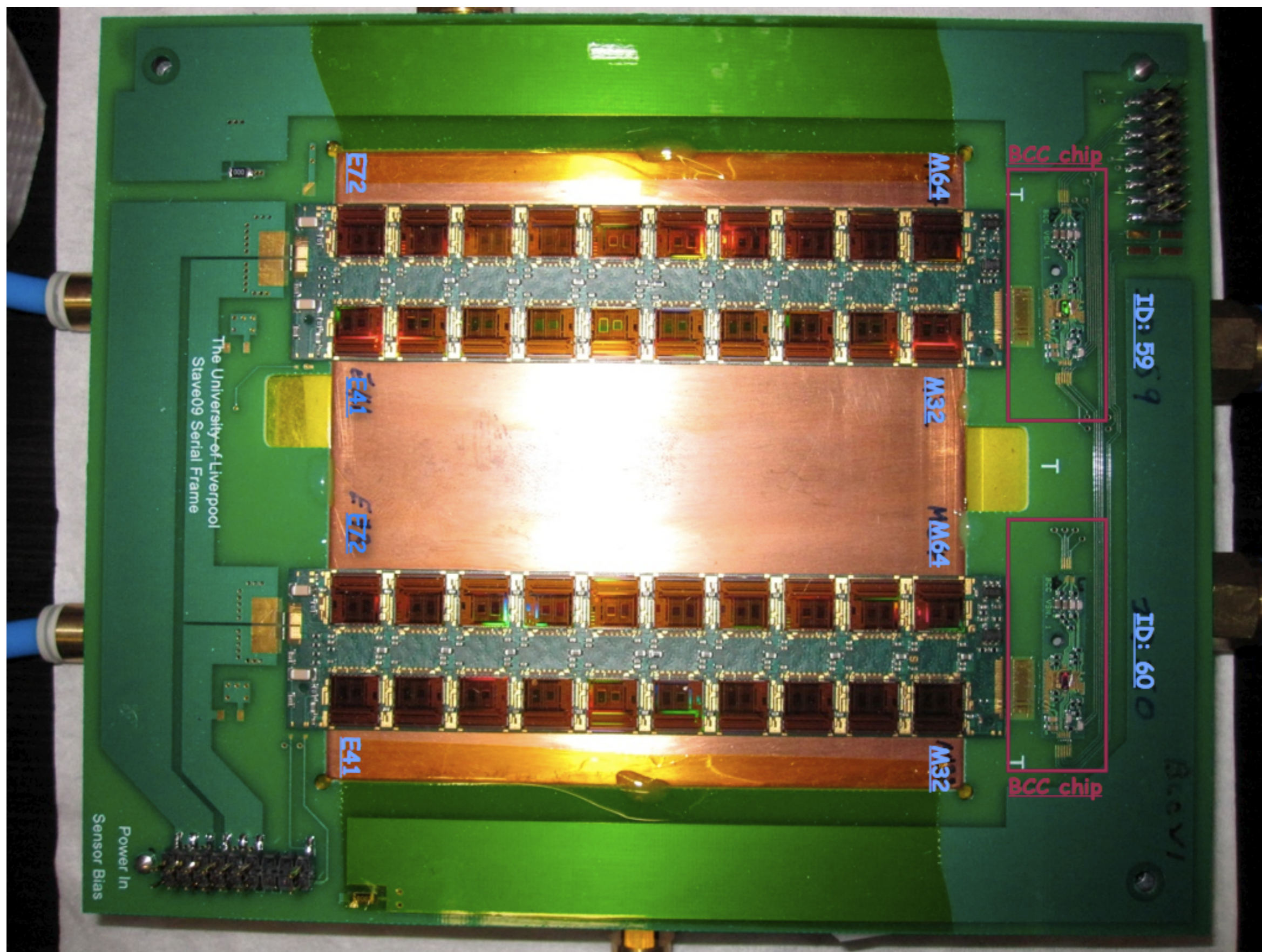
<----- Testing Module

HSIO (High-Speed Input/Output) Readout System

Page.09



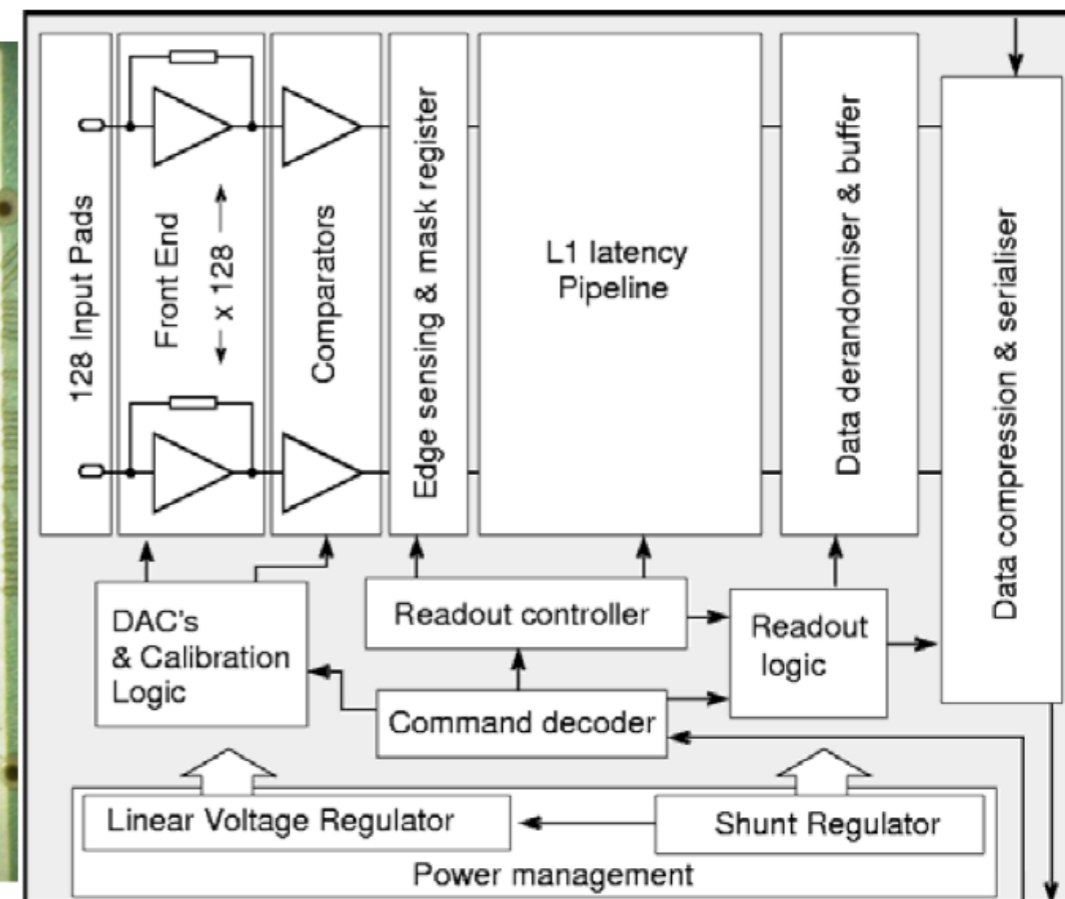
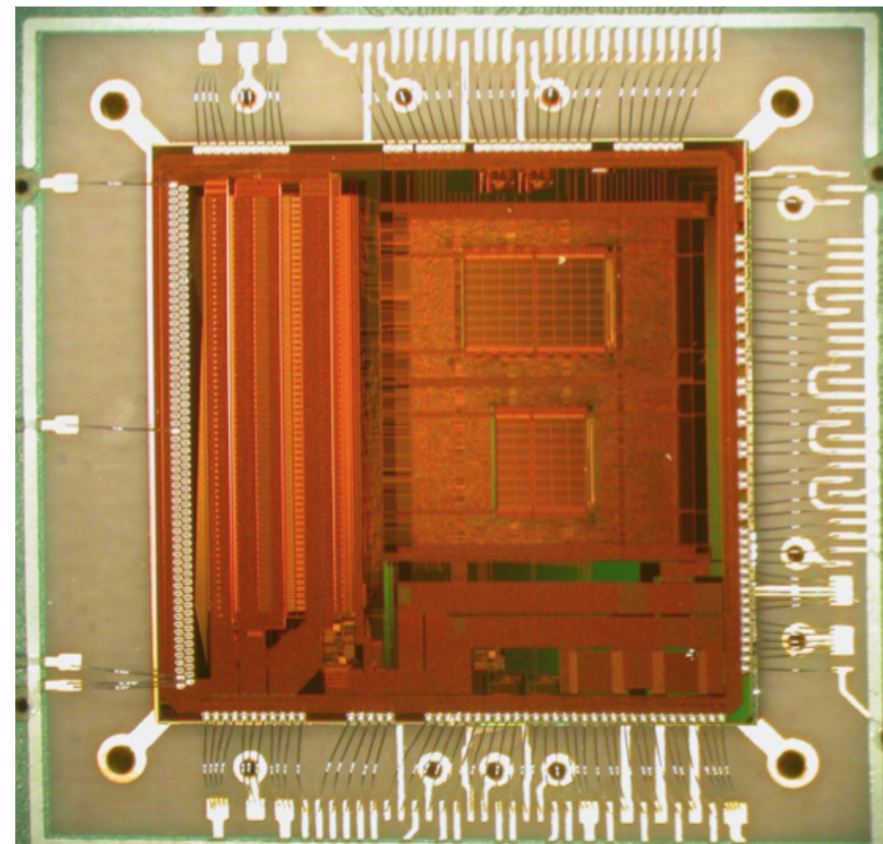
Dummy Module



Readout Concept

* Binary readout architecture

1. Charge injection (to simulate a particle passing through the detector)
2. Amplitude above the threshold : a hit "1",
below the threshold : no hit "0"
3. Trigger is sent to readout the hits



readout chip ----->
ATLAS Binary Chip- Next
(ABCN 25)

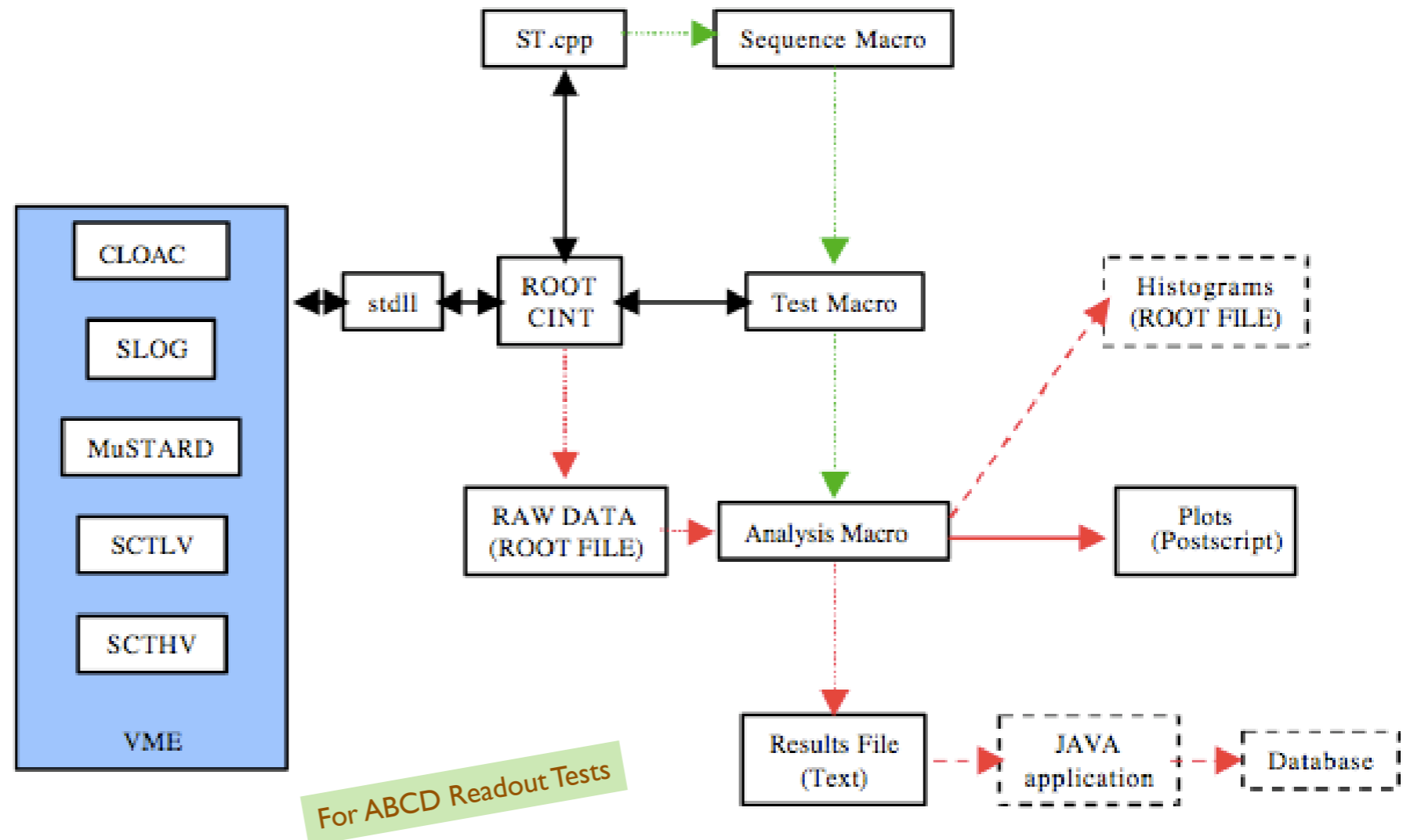
Structure of Redout System (Current)

- * Offline-Detector Readout Devices :
VME units (CLOAC, SLOG, MuSTARD)
are replaced by HSIO for the upgrade

CLOck And Control module (CLOAC)

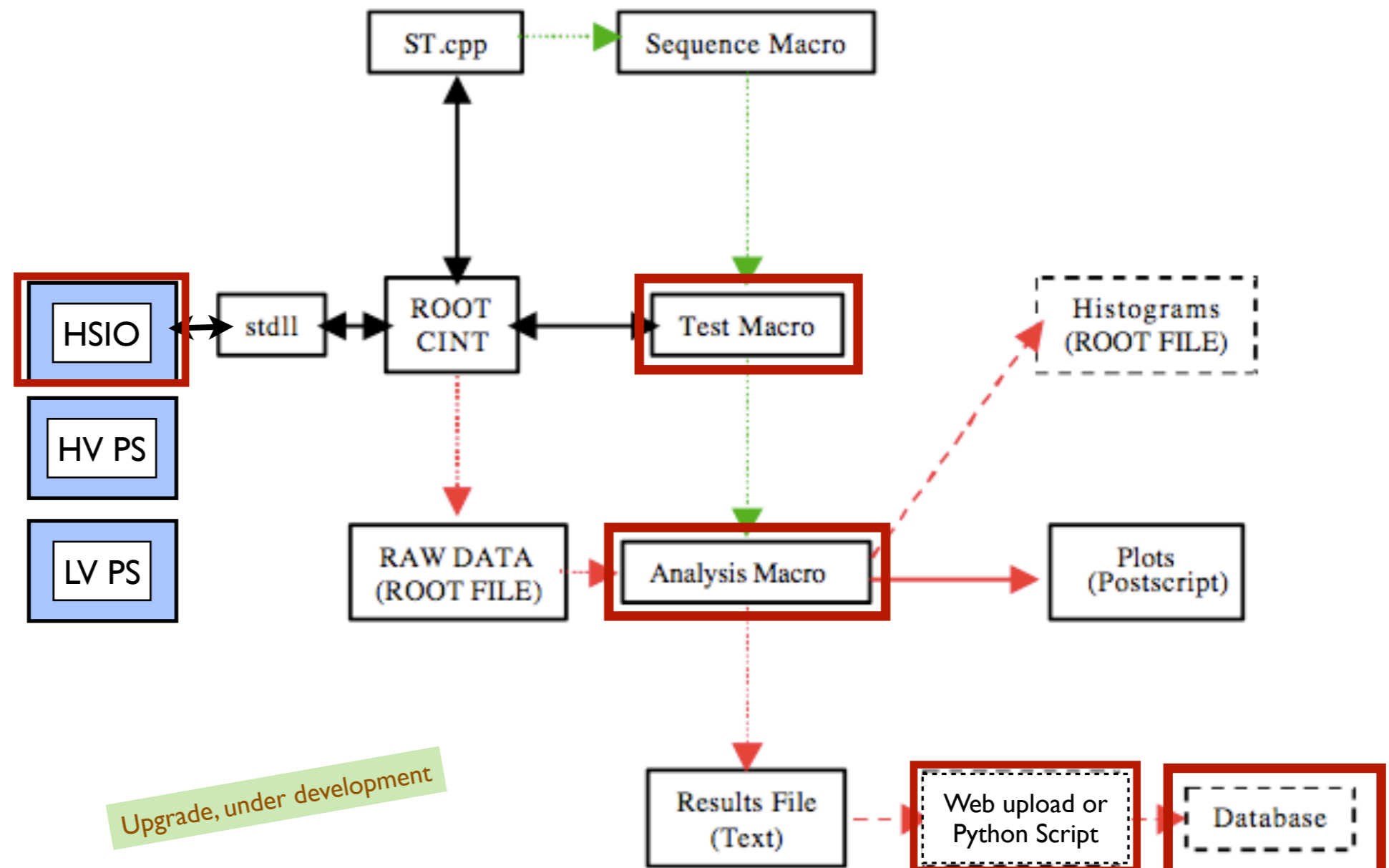
SLOw command Generator (SLOG)

Multi-channel Semiconductor Tracker
ABCD Readout Device (MuSTARD)



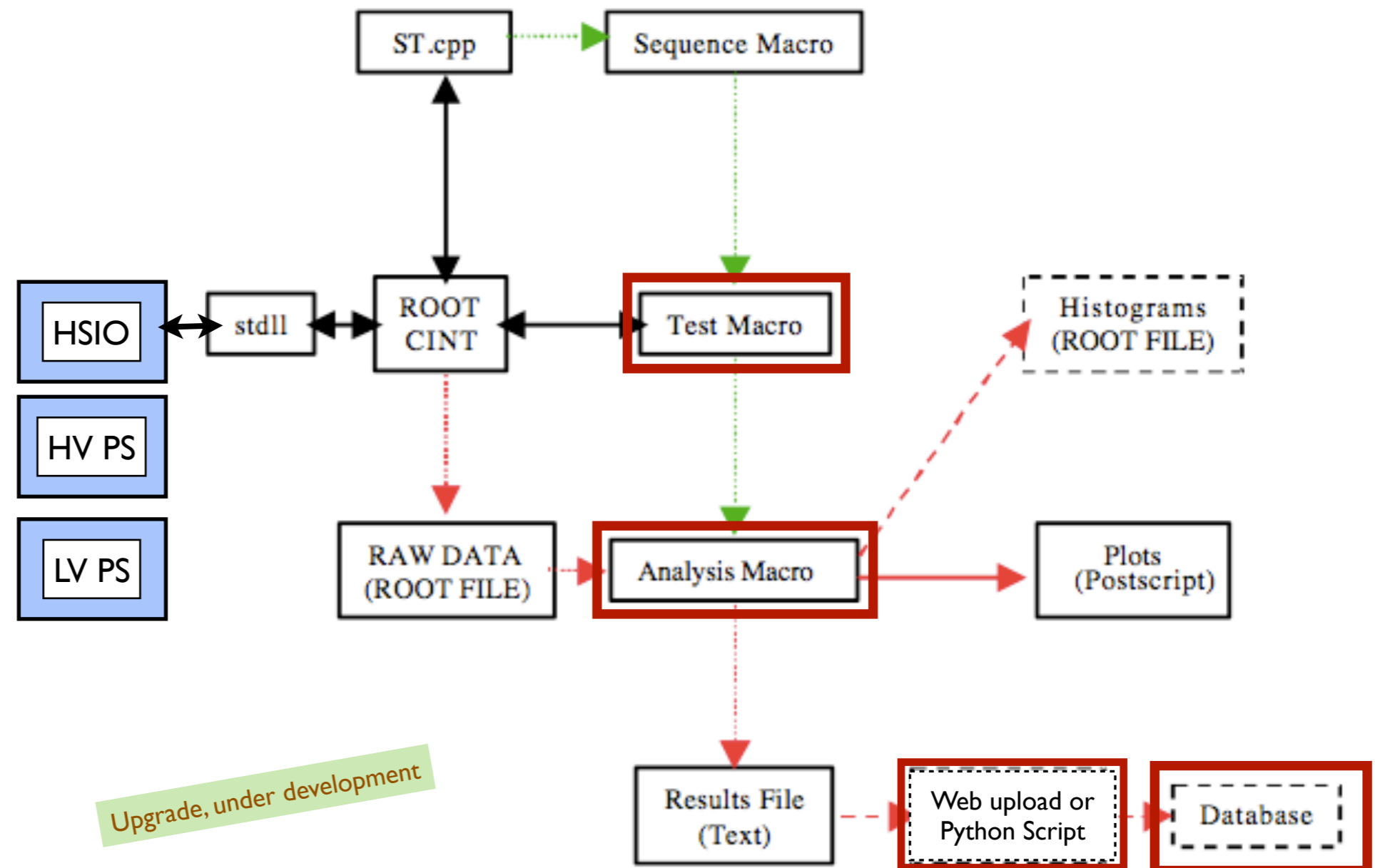
Structure of Redout System (Upgrade)

- * Offline-Detector Readout Devices : VME units (CLOAC, SLOG, MuSTARD) are replaced by HSIO for the upgrade



Redout Software - SCTupDAQ

- * Top level routine : in C++ & ROOT
- * Lower level routine : in C



Threshold Scan - basic concept of readout

- * SCTupDAQ is the threshold scan based examinations
- * Scan through thresholds with a fixed value of injected charge

- * Hit Probability w.r.t threshold

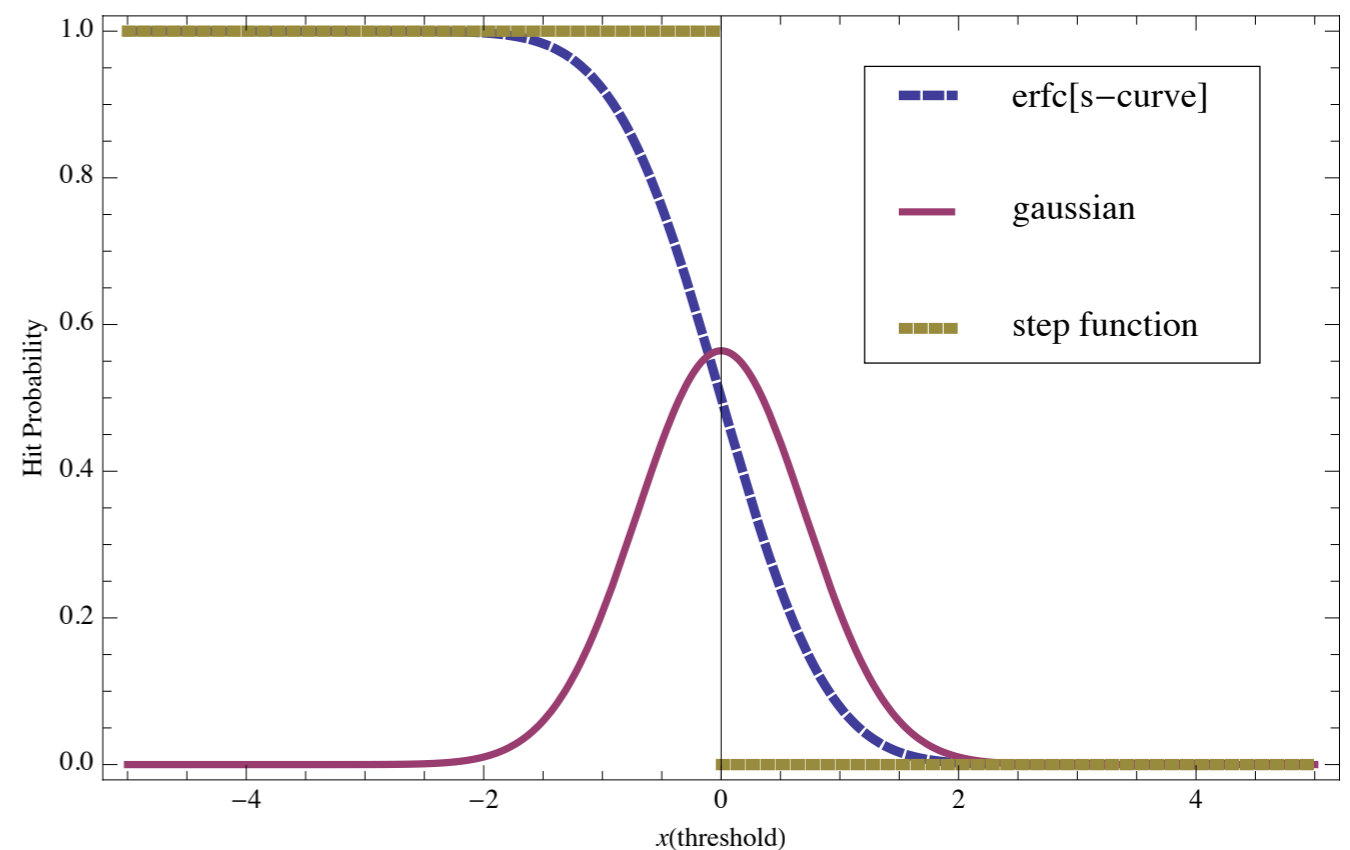
ideal: Step Function

reality: S-Curve (in the present of noise)

- * S-Curve can be fitted with complementary error function

V_{t50}: threshold voltage at 50% hit prob.

noise: σ_s of the Gaussian function



$$S(x) = \frac{1}{2} \operatorname{erfc}(x) = \frac{1}{2} (1 - \operatorname{erf}(x)) = \frac{1}{2} - \frac{1}{\sqrt{\pi}} \int e^{-x^2} dx = \frac{1}{2} - \frac{1}{\sqrt{\pi}} \int G(x) dx$$

$$x = \frac{V_{t50} - \mu_s}{\sqrt{2}\sigma_s}$$

Readout Tests

1. Strobe Delay

2. Gain Tests

3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.15

Goal:

characterization and confirmation of the module performance during the module production

Main Tests:

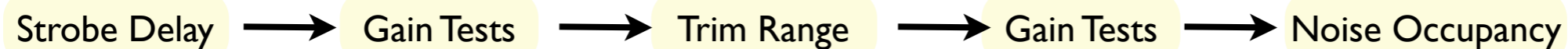
Strobe Delay : optimize the timing of the injected charge *calibration*

Gain Tests (3 Point Gain & Response Curve) : V_{t50} , response, and noise performance

Trim Range : minimise the channel to channel variations of the threshold *calibration*

Noise Occupancy : direct measure of the noise present in a channel

Procedure:



Readout Tests- Strobe Delay

1. Strobe Delay

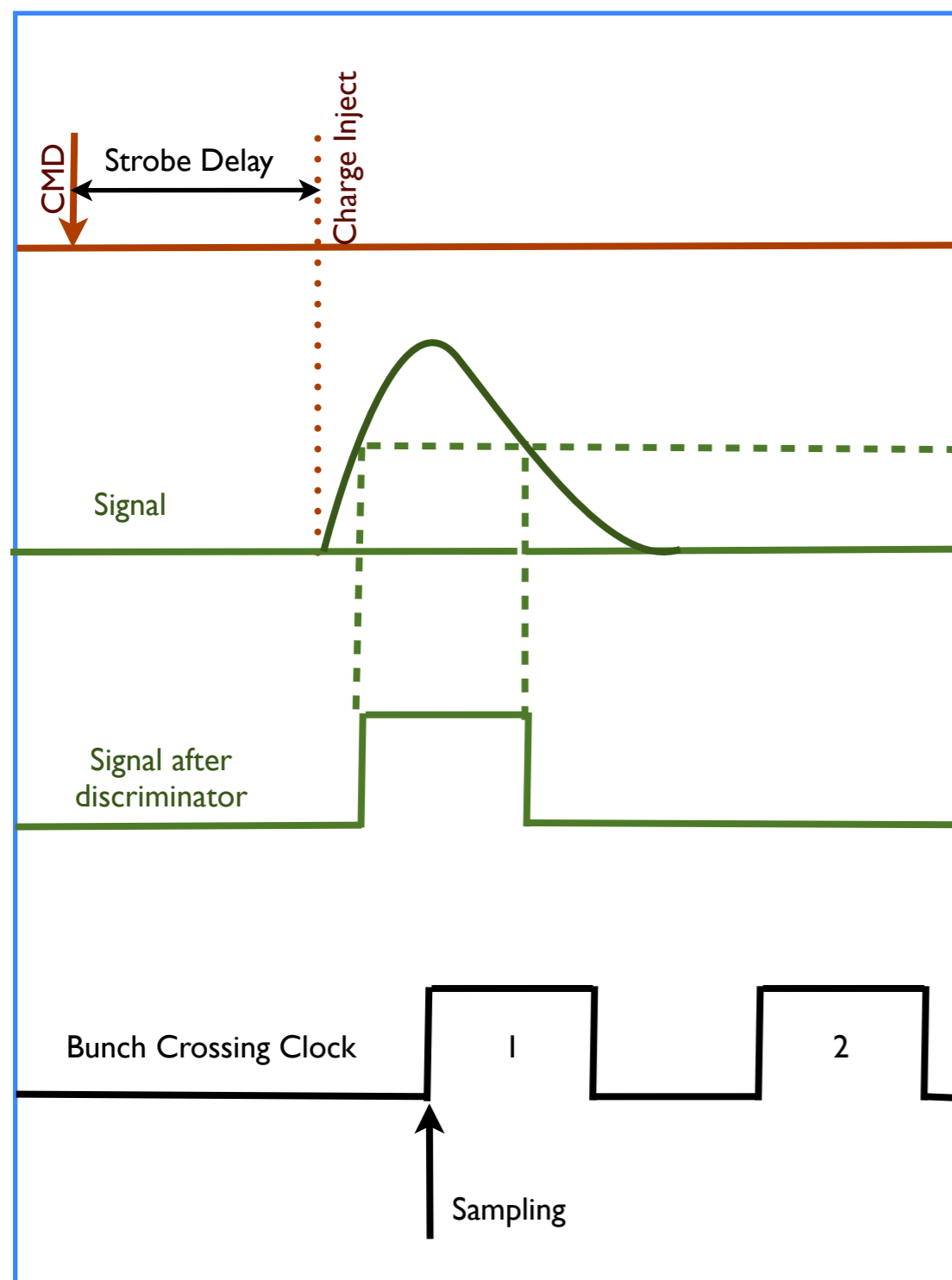
2. Gain Tests

3. Trim Range

4. Gain Tests

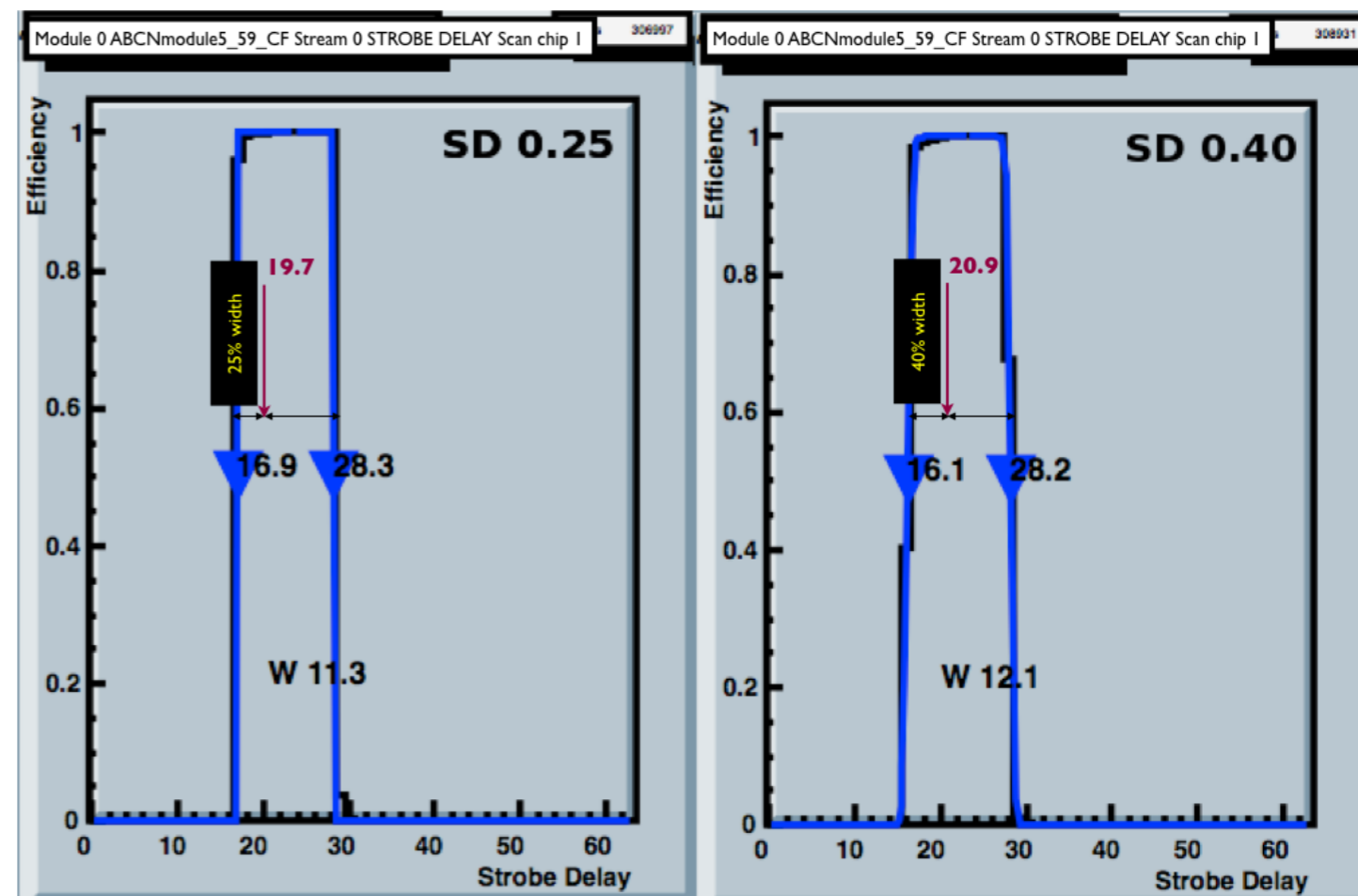
5. Noise Occupancy

Page.16



Delay the charge injection to sample signal in the correct phase of bunch crossing

Set at 25% (or 40%) of the working range as the timing to inject charge



Result of Dummy Module M59 strun 661 @Zeuthen

Readout Tests- Strobe Delay

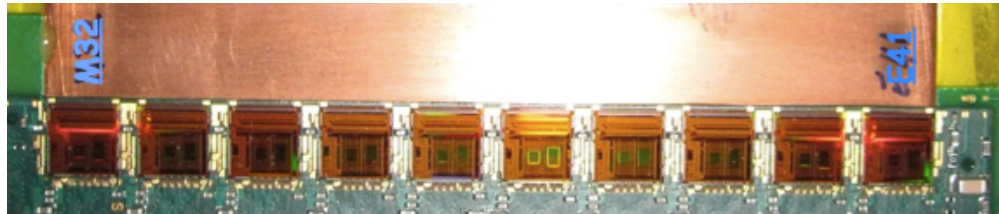
1. Strobe Delay

2. Gain Tests

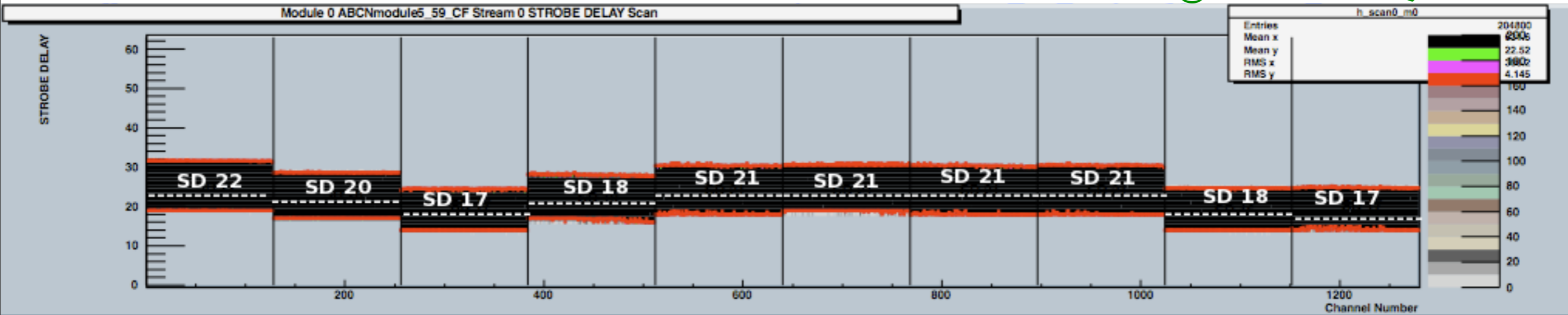
3. Trim Range

4. Gain Tests

5. Noise Occupancy

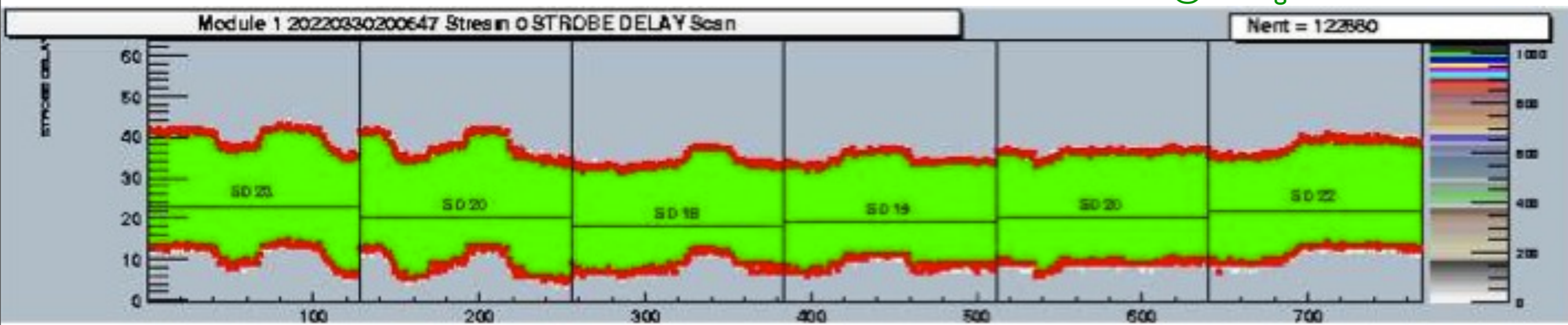


Result of Dummy Module M59 stream 0
strun 661 @Zeuthen SCTDAQ.trunk 1768



SD 0.40 is used in the situation of large channel to channel variation

Result of Barrel_Hybrid stream 0
strun 393 @Birmingham



Readout Tests- **Gain Tests**

1. Strobe Delay

2. Gain Tests

3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.18

Threshold scan with different injected charge

Response Curve shows linear behavior for lower injected charge

Linear Fit	$g = \frac{V_{t50_2} - V_{t50_1}}{q_2 - q_1} = p_1$
Exponential Fit	$g = \frac{p_0 e^{-\frac{q}{p_1}}}{p_1 \left(1 + e^{-\frac{q}{p_1}}\right)^2}$
Grillo Function Fit	$g = \frac{p_1}{\left(1 + \frac{p_1^2 q^2}{p_2^2}\right)^{\frac{3}{2}}}$
Polynomial Fit	$g = p_1 + 2p_2 q$

g , Gain (mV/fC)

q , Injected Charge (fC)

p_0 , Offset (mV)

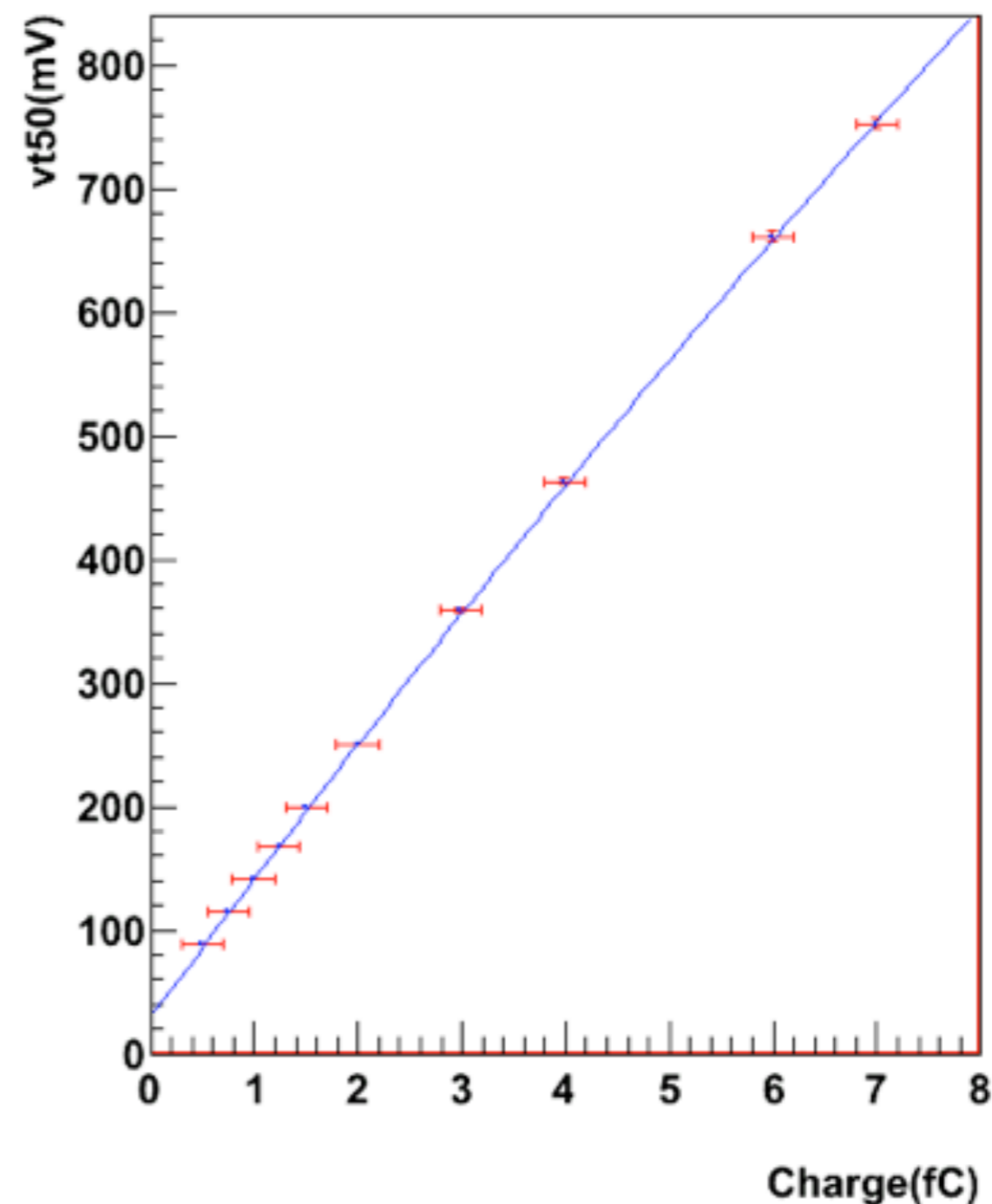
p_1 , Small Signal Gain

p_2 , measurement of the non-linearity

Result of Dummy Module M59 strun 661 @Zeuthen SCTDAQ.trunk 1768

Chip 1 Response Curve

Entries 0



Readout Tests- **Gain Tests**

1. Strobe Delay

2. Gain Tests

3. Trim Range

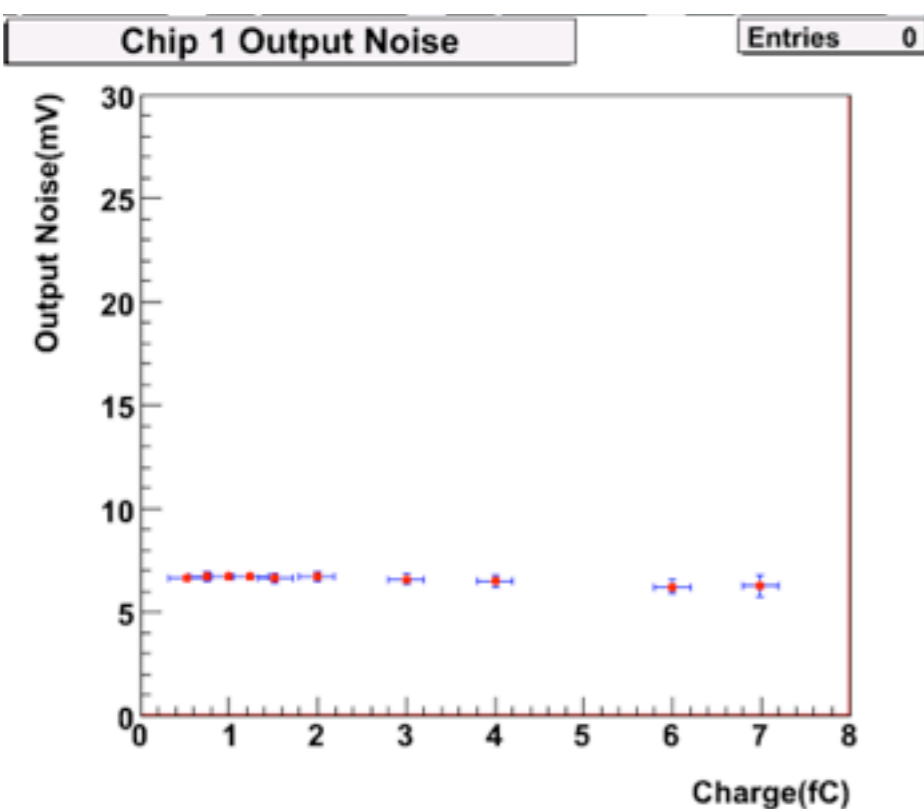
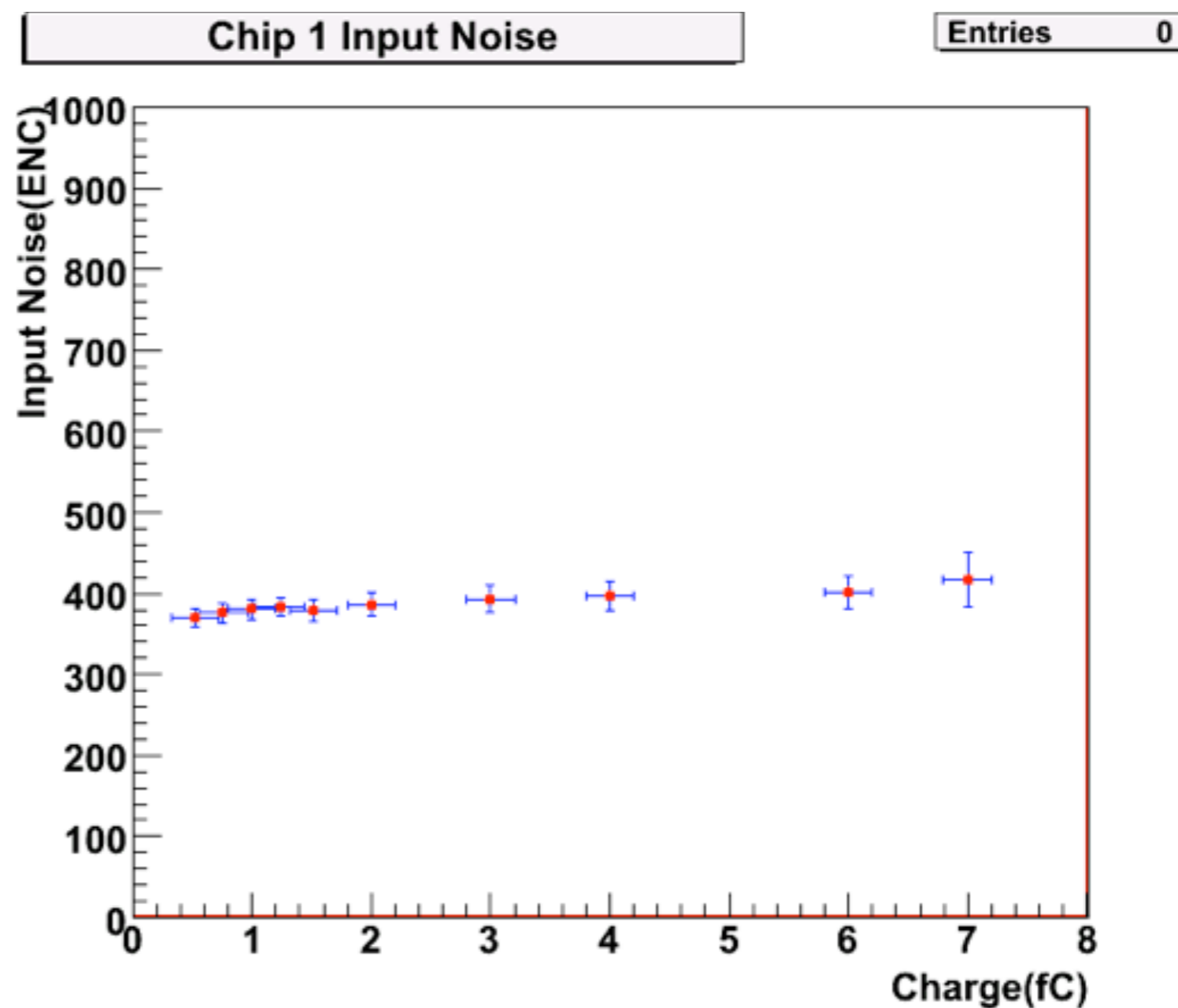
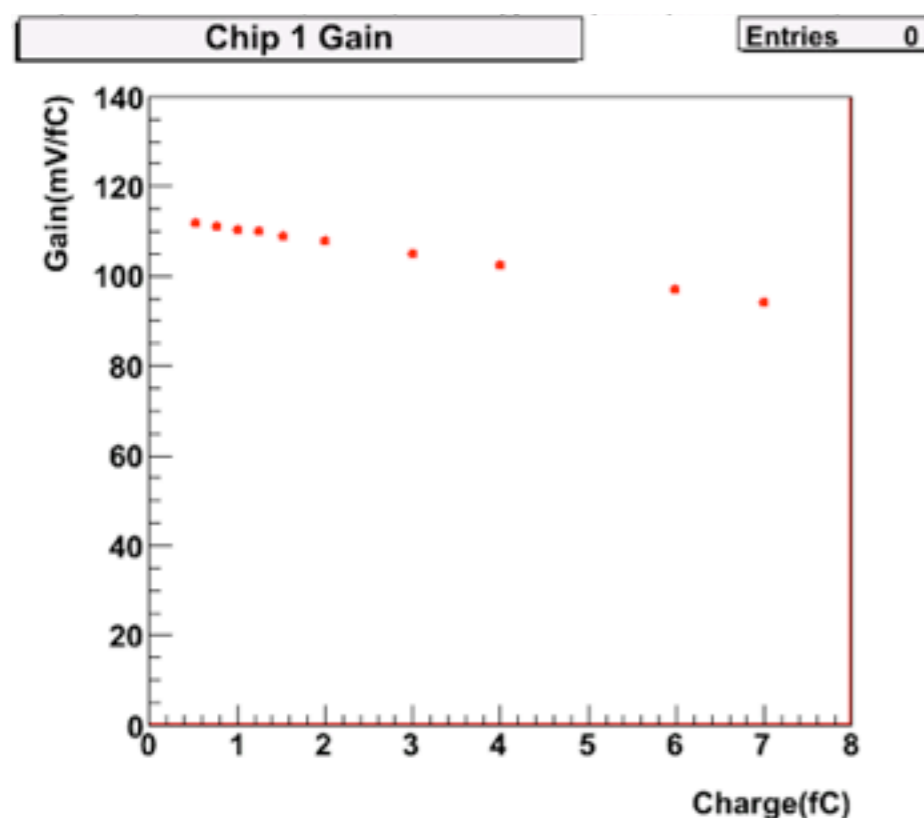
4. Gain Tests

5. Noise Occupancy

Page.19

$$\text{Input Noise} = 6250 \times \frac{\sigma_s}{\text{gain}}$$

ENC (Equivalent Noise Charge) | fC : 6250 e



Readout Tests- **Gain Tests**

1. Strobe Delay

2. Gain Tests

3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.20

	Injected Charge (fC)									
3PT 1fC	0.52	–	1.00	–	1.48	–	–	–	–	–
3PT 2fC	–	–	–	–	1.52	2.00	2.48	–	–	–
RC	0.52	0.76	1.00	1.24	1.52	2.00	3.00	4.00	6.00	7.00

	m59 (ENC)	m60 (ENC)
3PointGain 1fC	365 ± 20	373 ± 21
3PointGain 2fC	367 ± 21	378 ± 22
Response Curve	371 ± 18	383 ± 18

Input Noise Values

3PT (1fC) ~ 3PT (2fC) < RC

Output Noise values are at the same level, it might be due to the lower gain for higher injected charge

Readout Tests- **Gain Tests**

1. Strobe Delay

2. Gain Tests

3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.21

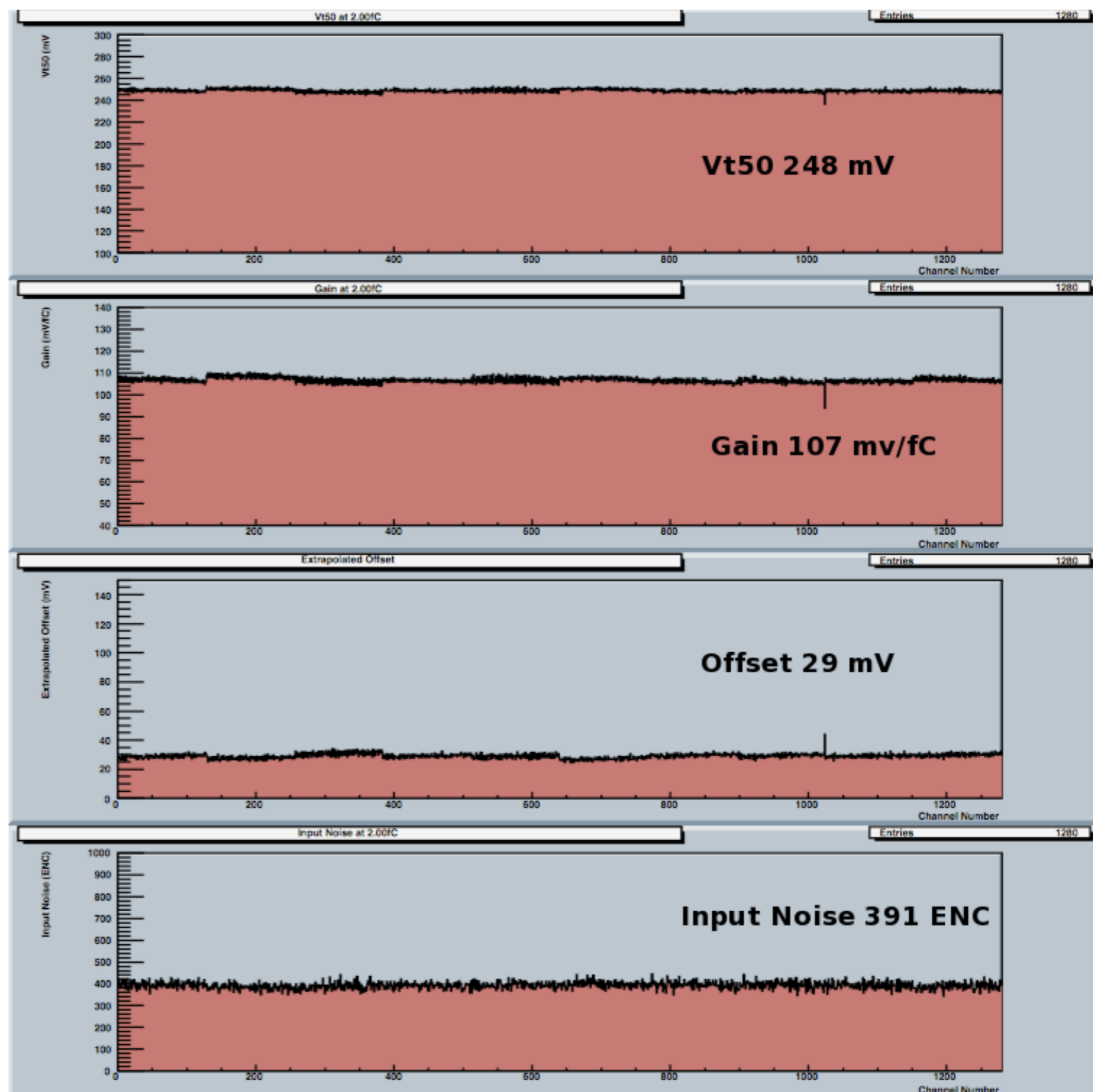
- * Gain Test result of all 1280 channels (10 chips)

- * Vt50 at injected charge of 2fC

- * **Input Noise**

The main index now commonly used in SCT community to determine the performance of the module or system

Result of Dummy Module M59 stream 0
strun 661 @Zeuthen SCTDAQ.trunk 1768



Readout Tests- Trim Range

1. Strobe Delay

2. Gain Tests

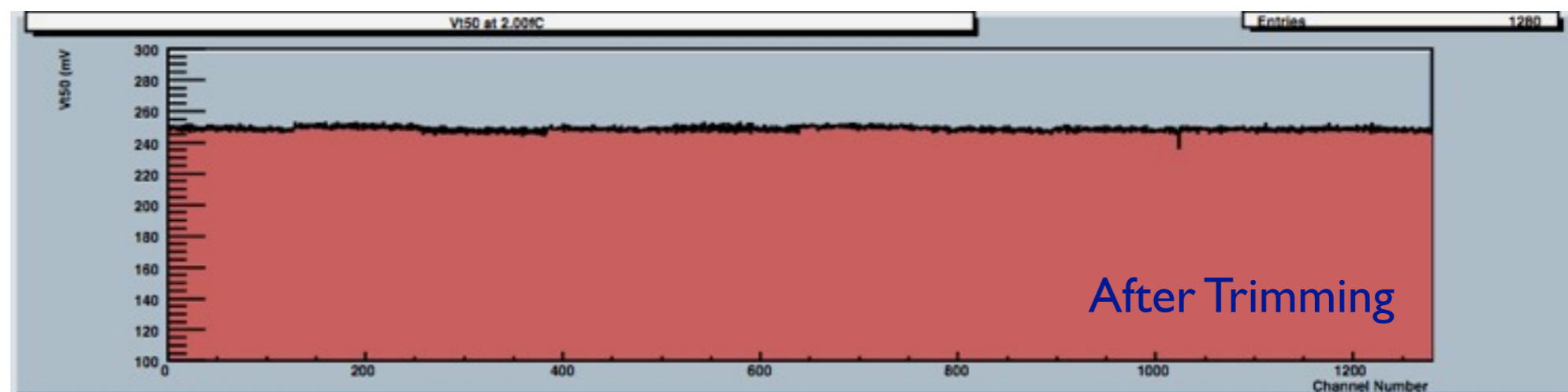
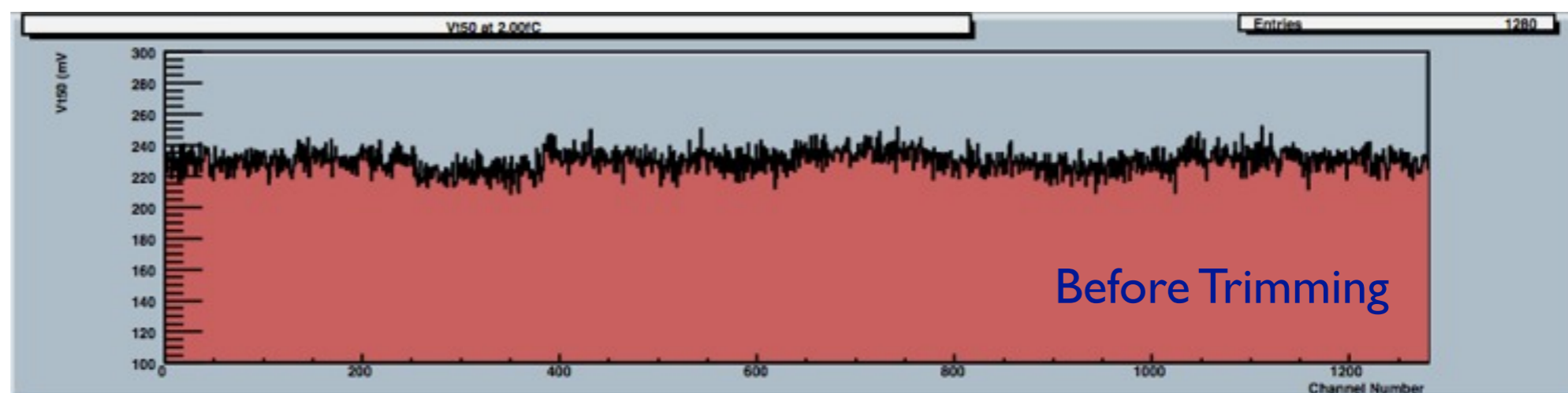
3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.22

- * To keep the homogeneity of performance across all channels, Threshold for each channel has to be tuned
- * 8 target thresholds are acquired to be trimmed (with 8 different trim steps and ranges),
- * The channels are not able to be trimmed, they are masked



Readout Tests- Trim Range

1. Strobe Delay

2. Gain Tests

3. Trim Range

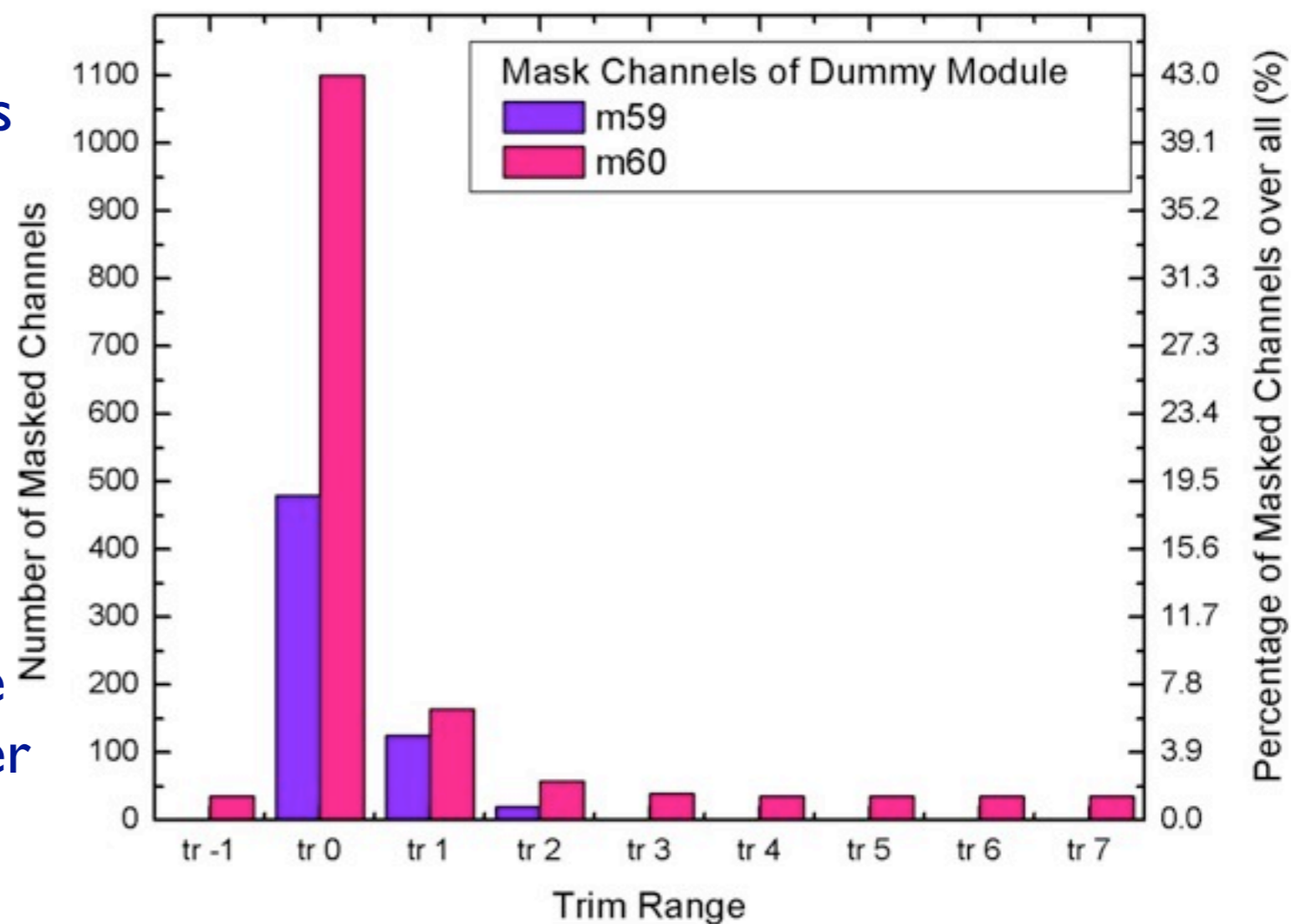
4. Gain Tests

5. Noise Occupancy

Page.23

- * 8+1 different trim and mask results
- * the optimize one:
 1. less masked channels
 2. smaller trim ranges

If the target threshold can not be trimmed by small trim step, there are more channels masked than the larger trim range



Result of Dummy Module strun 661 @Zeuthen SCTDAQ.Windows version

Readout Tests- **Noise Occupancy**

1. Strobe Delay

2. Gain Tests

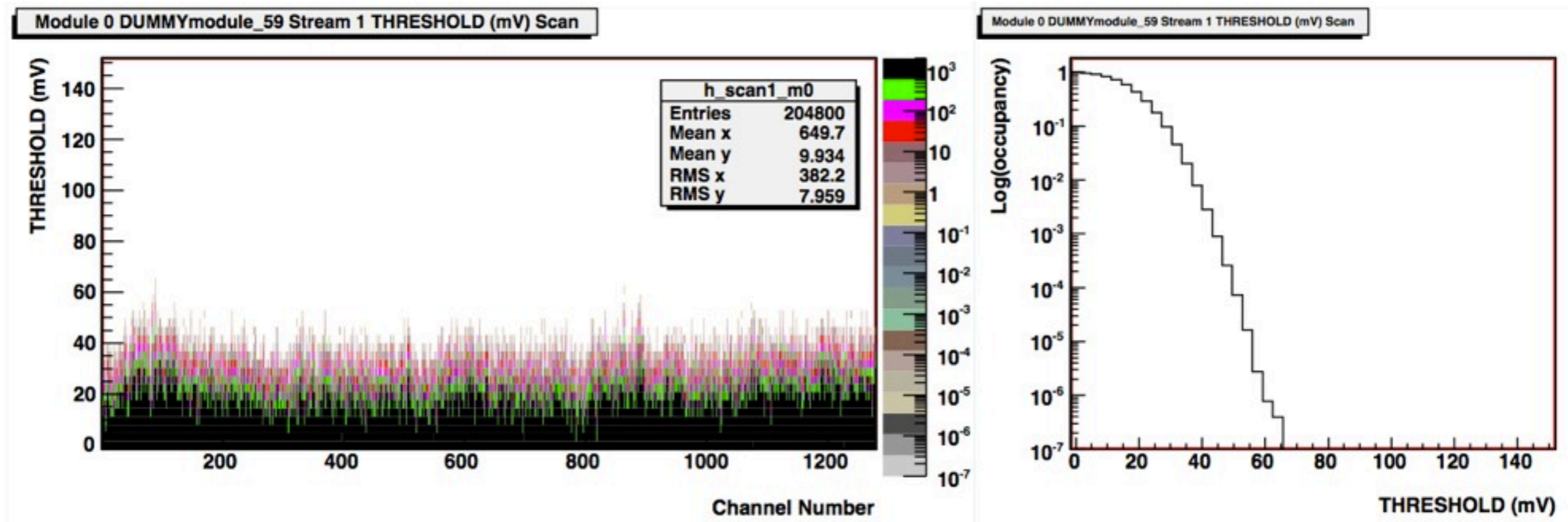
3. Trim Range

4. Gain Tests

5. Noise Occupancy

Page.24

- * Measured without injecting charge
- * Send 2000 triggers to readout the signal
- * Reduce the statistical error by sending more triggers



Result of Dummy Module strun 570 @Zeuthen Modified Version

Readout Tests- **Noise Occupancy**

1. Strobe Delay

2. Gain Tests

3. Trim Range

4. Gain Tests

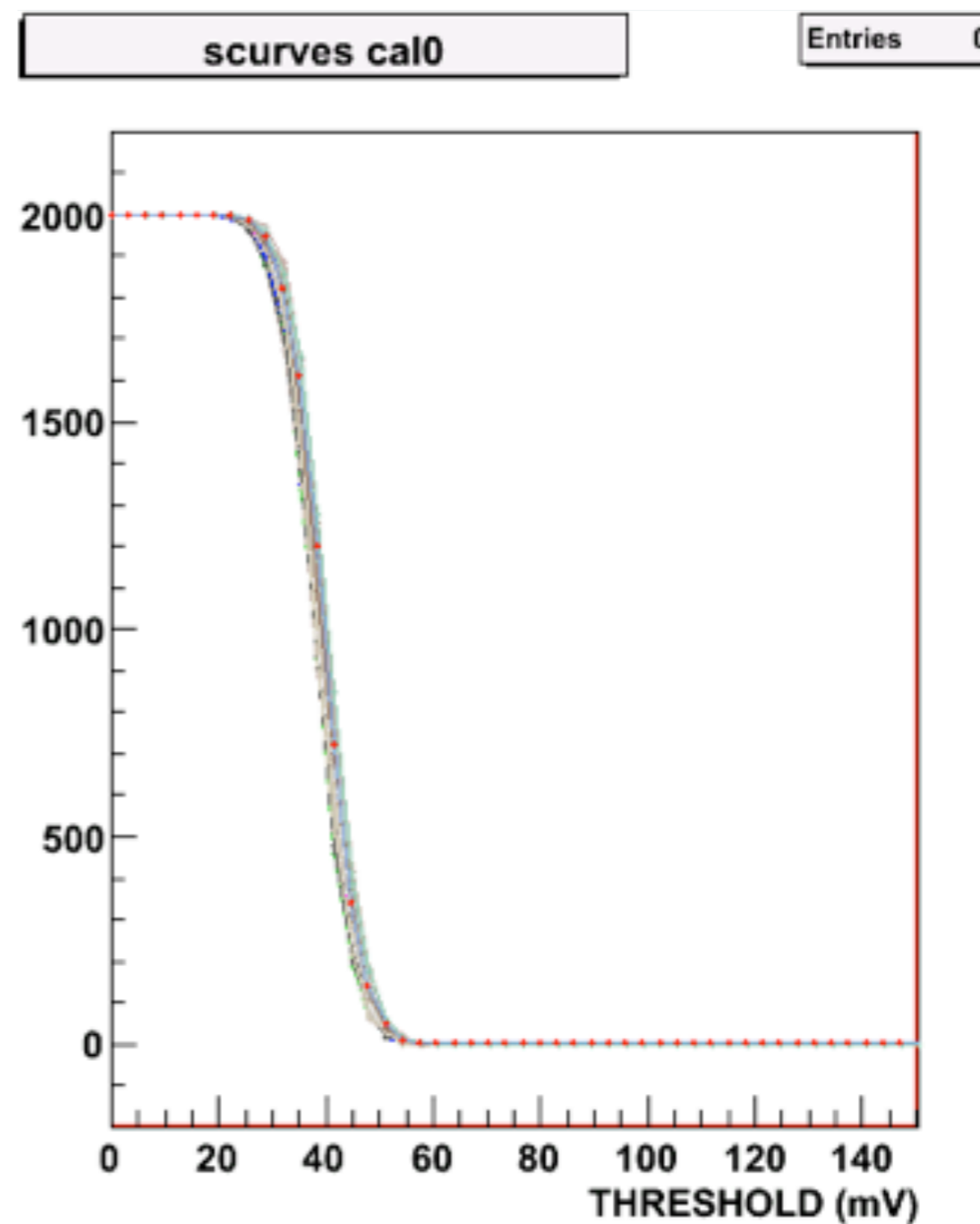
5. Noise Occupancy

Page.25

* S-Curve from Noise Occupancy

* V_{t50} can be converted from mV to fC by result from Gain Tests

Result of Dummy Module strun 570 @Zeuthen
Modified Version



Local Database System

CEC DB


ifh.de https://www.ifh.de/asdb/measaction

Google

最常用浏览 News APPLE

CEC DB

Zeuthen Measurement Data Base



History

[Home](#) | [Restricted Area](#) | [Logout](#)

Measurements	Modifications	Simulations	Shipments	Free actions
Measurement	Modification	Simulation	Shipment	Free action
Measurement values	Modification values	Simulation values	Shipment values	Free action values

Entered measurements

Add a measurements file

Id	History	Uploaddate	Filename	Errorflag	attached files				
16	2011-09-28	2011-09-28	2011/09/28/ABCNmodule5_60_CF_RC_321_3.txt	0	ABCNmodule5_60_CF_RCPlot_20110926_141143.ps	View	Edit	Plot	<input type="checkbox"/>
15	2011-09-28	2011-09-28	2011/09/28/ABCNmodule5_59_CF_RC_321_3.txt	1	ABCNmodule5_59_CF_RCPlot_20110926_141143.ps	View	Edit	Plot	<input type="checkbox"/>
14	2011-09-28	2011-09-28	2011/09/28/ABCNmodule5_60_CF_RC_321_38.txt	1	ABCNmodule5_60_CF_RCPlot_20110926_144839.ps	View	Edit	Plot	<input type="checkbox"/>
12	2011-06-22	2011-06-23	2011/06/23/ABCNx20_01_RC_151_45.txt	0	ABCNmodule5_59_CF_RCPlot_20110926_144839.ps	View	Edit	Plot	<input type="checkbox"/>
9	2011-05-31	2011-06-14	2011/06/14/Example.txt	0		View	Edit	Plot	<input type="checkbox"/>

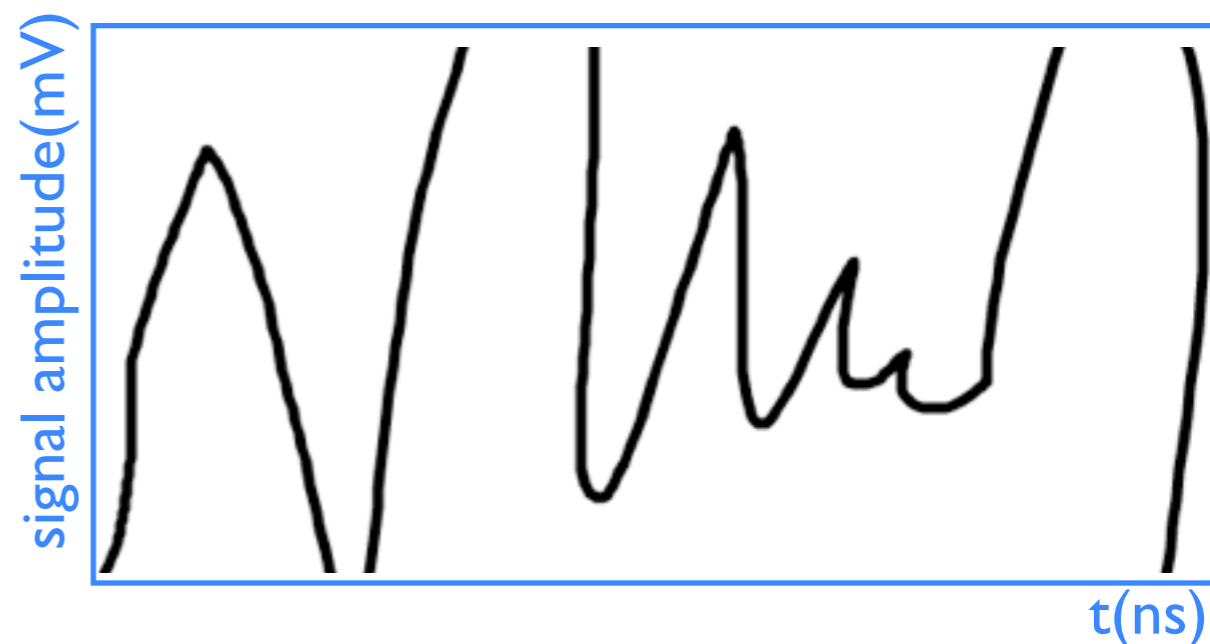
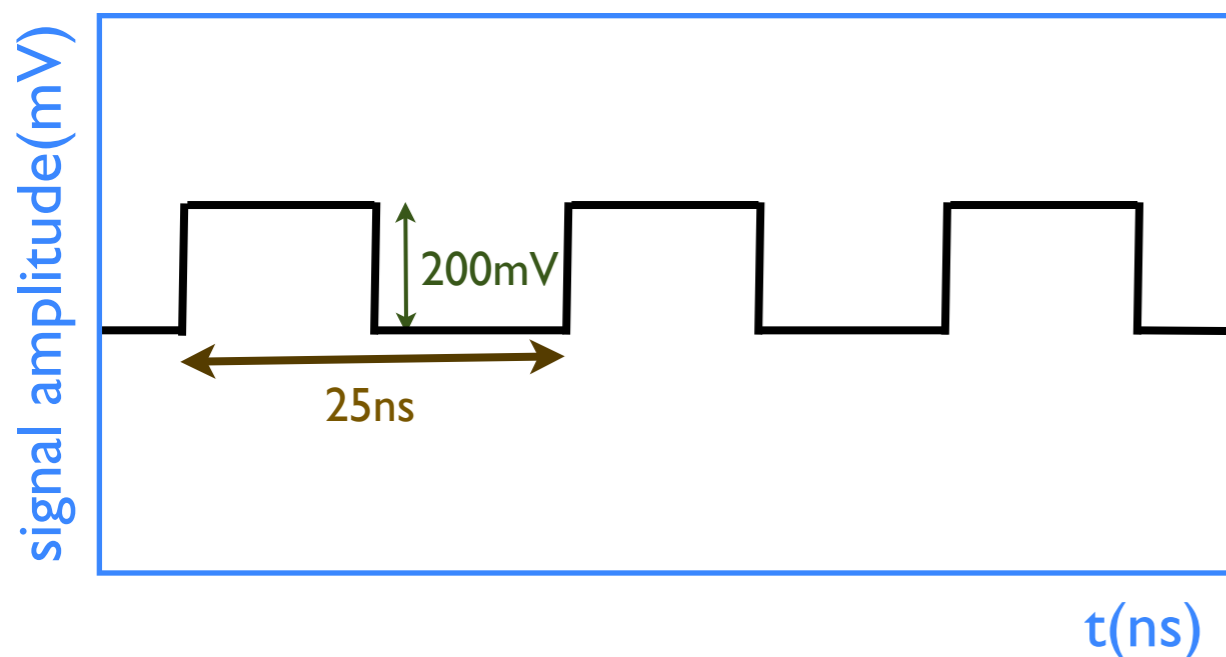
process
export
delete

System Stability - Electromagnetic Interference

* Example :

The bunch crossing clock signal during the test of single hybrid

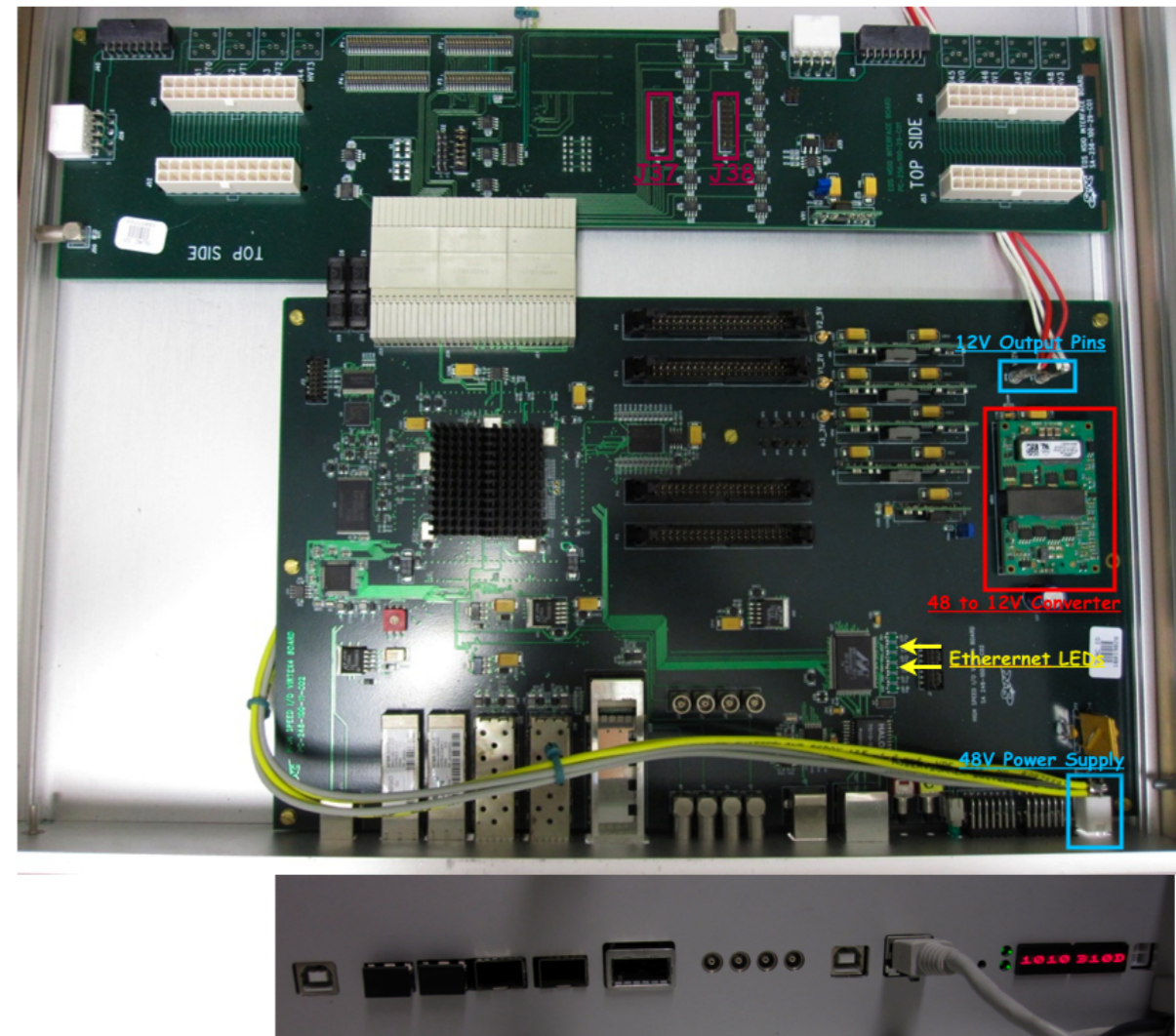
Electromagnetic impose noise on the bunch crossing clock signal in extreme case, can crash the readout software



Noise Hunting - Different Way to Power HSIO

Powering the HSIO without large DC-DC converters (noisy)

Other group observe different behavior (under investigation)



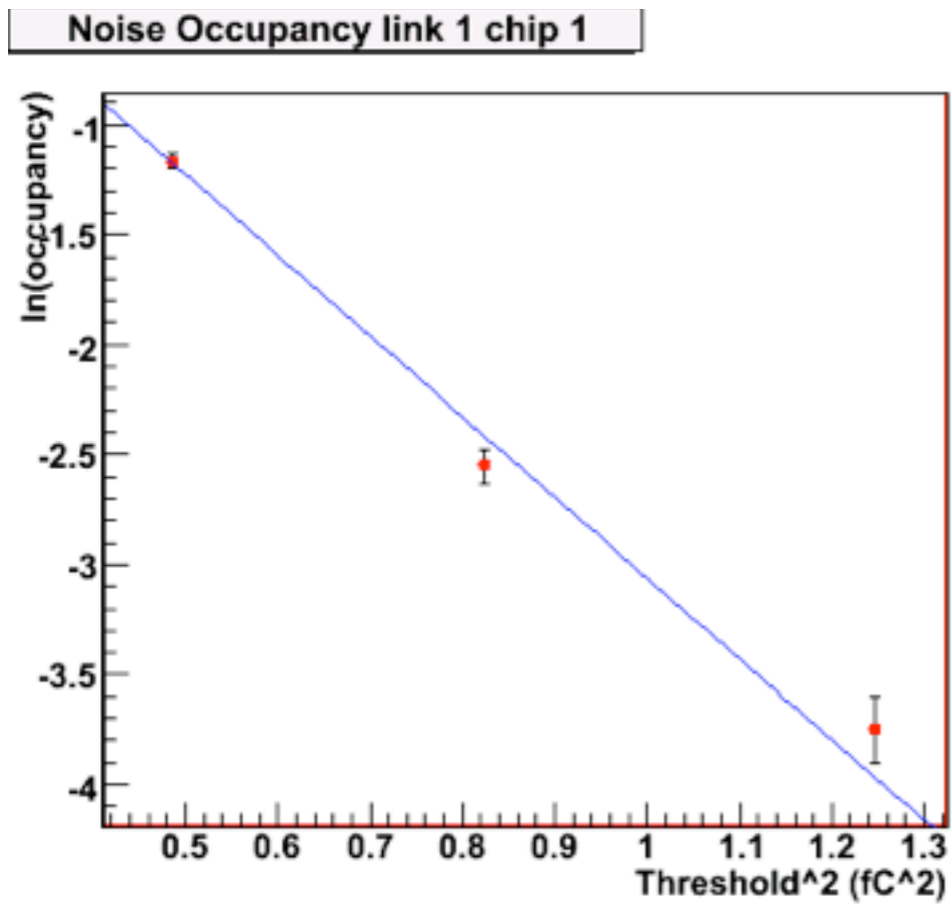
	m59 (3PT 1fC)	m59 (3PT 2fC)	m60 (3PT 1fC)	m60 (3PT 2fC)
48 V	401 ± 21	449 ± 27	403 ± 29	453 ± 33
12 V	412 ± 25	464 ± 29	409 ± 29	464 ± 67

Summary & Conclusion & Outlook



- * Upgrade of LHC & ATLAS Detector
- * DESY focus on module production and testing
- * HSIO based readout system and the SCTupDAQ software set up (further debugging is still on going)
 - ready for the future module production & testing
- * Test results of dummy module
 - Strobe Delay, Gain tests, Trim Range, Noise Occupancy
- * The Zeuthen Database
 - Modified the interface to local database
- * Stability and Noise hunting of the readout system
 - The sources of system instability identified, noise hunting season has not yet ended

- * the behaviour of $\ln(O)$ should be linear as the theory predicted

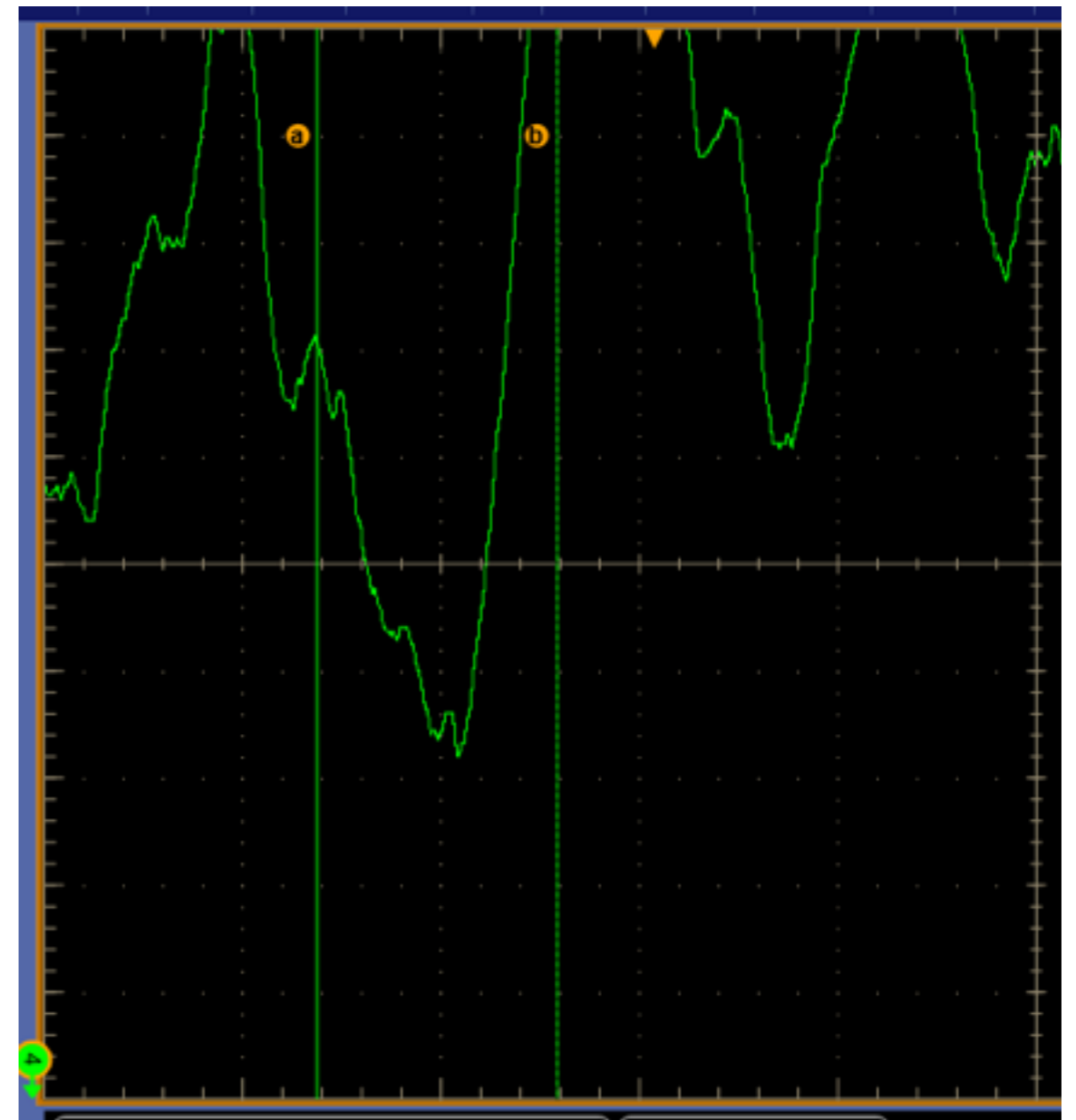
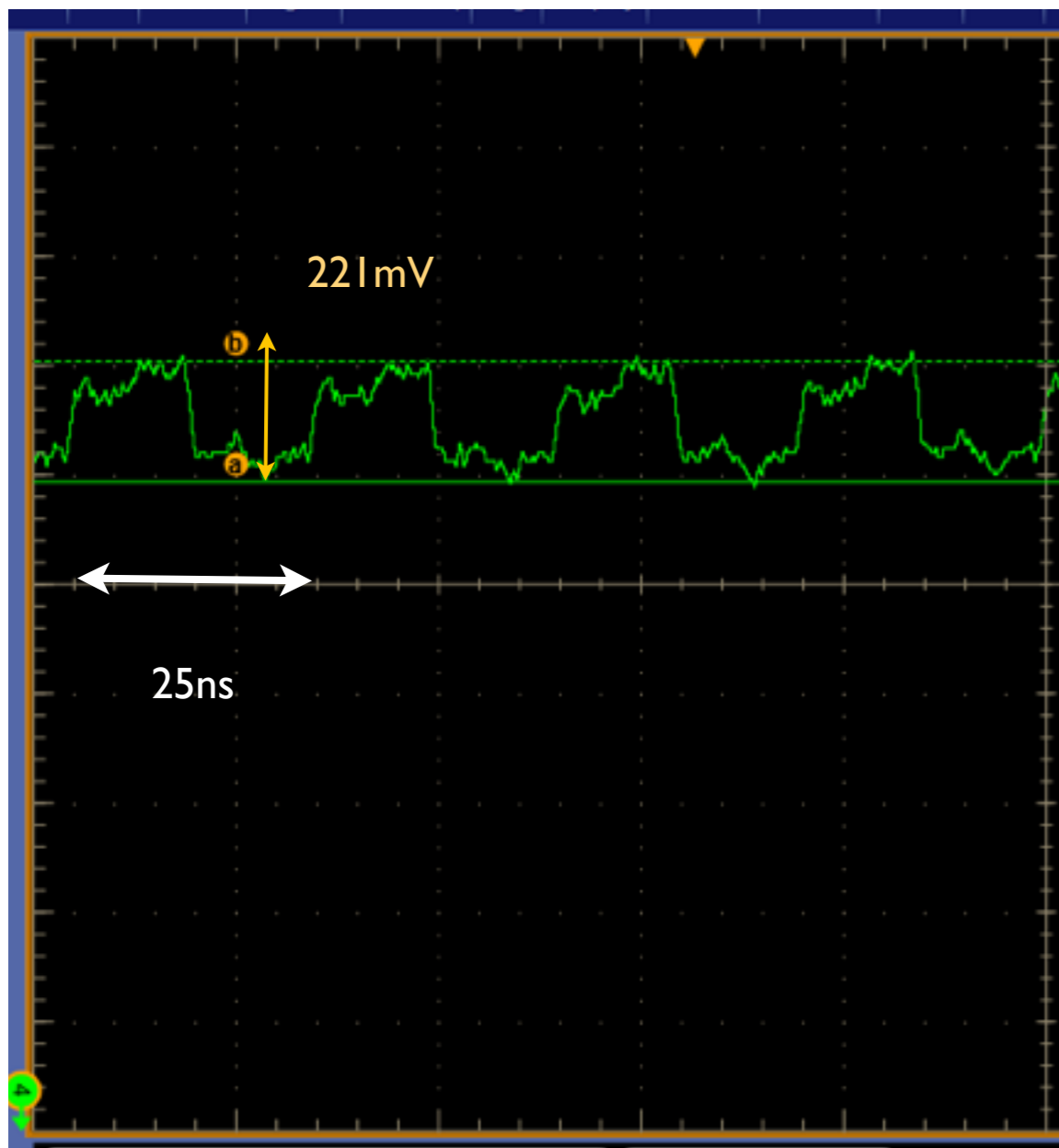


$$\ln(O) \approx -\frac{1}{2}V_{\text{thr}}^2 - \ln\left(\sqrt{2\pi}V_{\text{thr}}\right)$$

Electromagnetic Interference



- * The bunch crossing clock signal during the test of signal hybrid
- * The signal from electromagnetic interference superpositon the bunch crossing clock signal and make the readout terminated



Trim DAC Code (bit2 bit1 bit0)	Trim DAC range	Trim DAC step
0 0 0	0 mV – 14.88 mV	0.48 mV
0 0 1	0 mV – 22.32 mV	0.72 mV
0 1 0	0 mV – 29.76 mV	0.96 mV
0 1 1	0 mV – 37.20 mV	1.20 mV
1 0 0	0 mV – 44.64 mV	1.44 mV
1 0 1	0 mV – 59.52 mV	1.92 mV
1 1 0	0 mV – 74.40 mV	2.40 mV
1 1 1	0 mV – 89.28 mV	2.88 mV

